

GD25LB256D

DATASHEET





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1. FEATURES

- 256M-bit Serial Flash
 -32768K-byte
 -256 bytes per programmable page
- Standard, Dual, Quad SPI, QPI
 Standard SPI: SCLK, CS#, SI, SO
 Dual SPI: SCLK, CS#, IO0, IO1
 Quad SPI: SCLK, CS#, IO0, IO1, IO2, IO3
 QPI: SCLK, CS#, IO0, IO1, IO2, IO3
- High Speed Clock Frequency
 -120MHz for fast read with 30PF load
 -Dual I/O Data transfer up to 240Mbits/s
 -Quad I/O Data transfer up to 480Mbits/s
 -QPI Mode Data transfer up to 480Mbits/s
- Allows XIP (execute in place) Operation
 Continuous Read With 8/16/32/64-byte Wrap
- Software Write Protection
 -Write protect all/portion of memory via software
 -Top or Bottom, Sector or Block selection
- Cycling endurance
 -Minimum 100,000 Program/Erase Cycles

Program/Erase Speed
 Page Program time: 0.5ms typical
 Sector Erase time: 70ms typical
 Block Erase time: 0.16/0.3s typical

-Chip Erase time: 100s typical

- Flexible Architecture
 -Uniform Sector of 4K-byte
 -Uniform Block of 32/64K-byte
 -Erase/Program Suspend/Resume
- Low Power Consumption
 -70uA typical stand-by current
 -2uA typical power down current
- Advanced security Features
 -128-Bit Unique ID for each device
 -2x1024-Byte Security Registers With OTP Lock
- Single Power Supply Voltage
 Full voltage range: 1.65~2.0V
- Data Retention
 -20-year data retention typical

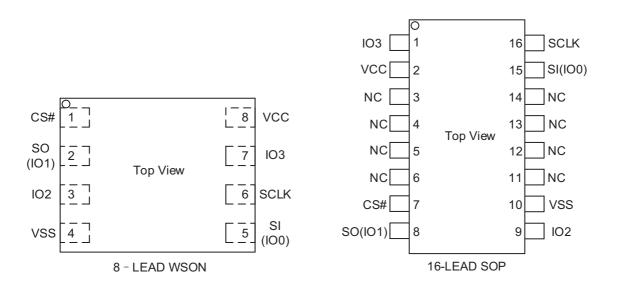
GD25LB256D



2. GENERAL DESCRIPTION

The GD25LB256D (256M-bit) Serial flash supports the standard Serial Peripheral Interface (SPI), and supports the Dual/Quad SPI and QPI mode: Serial Clock, Chip Select, Serial Data I/O0 (SI), I/O1 (SO), I/O2, and I/O3. The Dual I/O data is transferred with speed of 240Mbits/s and the Quad I/O & Quad output data is transferred with speed of 480Mbits/s.

CONNECTION DIAGRAM



PIN DESCRIPTION

Pin Name	I/O	Description
CS#	1	Chip Select Input
SO (IO1)	I/O	Data Output (Data Input Output 1)
102	I/O	Data Input Output 2
VSS		Ground
SI (IO0)	I/O	Data Input (Data Input Output 0)
SCLK	1	Serial Clock Input
103	I/O	Data Input Output 3
VCC		Power Supply

Note:

1. CS# must be driven high if chip is not selected. Please don't leave CS# floating any time after power is on.

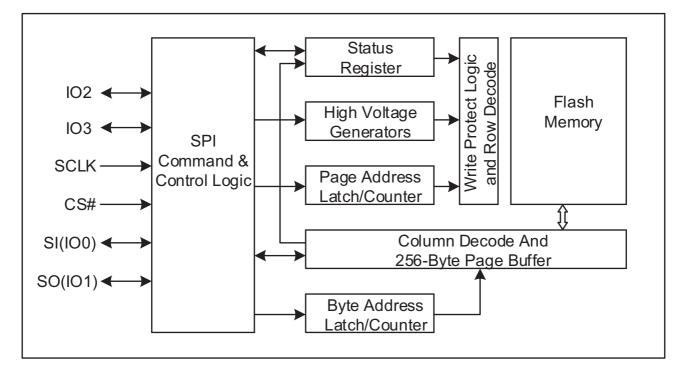
2. The NC pin/ball is not connected to any internal signal. It is OK to connect it to the system ground (GND) or leave it floating.







BLOCK DIAGRAM







MEMORY ORGANIZATION 3.

GD25LB256D

Each device has	Each block has	Each sector has	Each page has	
32M	64/32K	4K	256	bytes
128K	256/128	16	-	pages
8192	16/8	-	-	sectors
512/1024	-	-	-	blocks

UNIFORM BLOCK SECTOR ARCHITECTURE GD25LB256D 64K Bytes Block Sector Architecture

Block	Sector	Addres	s range
	8191	1FFF000H	1FFFFFH
511			
	8176	1FF0000H	1FF0FFFH
	8175	1FEF000H	1FEFFFFH
510			
	8160	1FE0000H	1FE0FFFH
	47	02F000H	02FFFFH
2			
	32	020000H	020FFFH
	31	01F000H	01FFFFH
1			
	16	010000H	010FFFH
	15	00F000H	00FFFFH
0			
	0	000000H	000FFFH





4. DEVICE OPERATION

SPI Mode

Standard SPI

The GD25LB256D features a serial peripheral interface on 4 signals bus: Serial Clock (SCLK), Chip Select (CS#), Serial Data Input (SI) and Serial Data Output (SO). Both SPI bus mode 0 and 3 are supported. Input data is latched on the rising edge of SCLK and data shifts out on the falling edge of SCLK.

Dual SPI

The GD25LB256D supports Dual SPI operation when using the "Dual Output Fast Read" and "Dual I/O Fast Read" (3BH and BBH) commands. These commands allow data to be transferred to or from the device at twice the rate of the standard SPI. When using the Dual SPI command the SI and SO pins become bidirectional I/O pins: IO0 and IO1.

Quad SPI

The GD25LB256D supports Quad SPI operation when using the "Quad Output Fast Read", "Quad I/O Fast Read", "Quad I/O Word Fast Read", "Quad Page Program" (6BH, EBH, E7H, 32H) commands. These commands allow data to be transferred to or from the device at four times the rate of the standard SPI. When using the Quad SPI command the SI and SO pins become bidirectional I/O pins: IO0 and IO1.

QPI

The GD25LB256D supports Quad Peripheral Interface (QPI) operations only when the device is switched from Standard/Dual/Quad SPI mode to QPI mode using the "Enable the QPI (38H)" command. The QPI mode utilizes all four IO pins to input the command code. Standard/Dual/Quad SPI mode and QPI mode are exclusive. Only one mode can be active at any given times. "Enable the QPI (38H)" and "Disable the QPI (FFH)" commands are used to switch between these two modes. Upon power-up and after software reset using ""Reset (99H)" command, the default state of the device is Standard/Dual/Quad SPI mode.





5. DATA PROTECTION

The GD25LB256D provide the following data protection methods:

Write Enable (WREN) command: The WREN command is set the Write Enable Latch bit (WEL). The WEL bit will
return to reset by the following situation:

-Power-Up

-Write Disable (WRDI)

-Write Status Register (WRSR)

-Page Program (PP)

-Sector Erase (SE) / Block Erase (BE) / Chip Erase (CE)

-Erase Security Registers / Program Security Registers

-Software reset (66H+99H)

- Software Protection Mode: The Block Protect (BP4, BP3, BP2, BP1, and BP0) bits define the section of the memory array that can be read but not change.
- Deep Power-Down Mode: In Deep Power-Down Mode, all commands are ignored except the Release from Deep Power-Down Mode command and reset command (66H+99H).

9	Status F	Register	Conten	t		Memory Conte	nt	
BP4	BP3	BP2	BP1	BP0	Blocks	Addresses	Density	Portion
Х	X	0	0	0	NONE	NONE NONE		NONE
0	0	0	0	1	504 to 511	1F80000H-1FFFFFFH	512KB	Upper 1/64
0	0	0	1	0	495 to 511	1F00000H-1FFFFFFH	1MB	Upper 1/32
0	0	0	1	1	479 to 511	1E00000H-1FFFFFFH	2MB	Upper 1/16
0	0	1	0	0	447 to 511	1C00000H-1FFFFFFH	4MB	Upper 1/8
0	0	1	0	1	384 to 511	1800000H-1FFFFFFH	8MB	Upper 1/4
0	0	1	1	0	256 to 511	1000000H-1FFFFFH	16MB	Upper 1/2
0	1	0	0	1	0 to 7	000000H-07FFFFH	512KB	Lower 1/64
0	1	0	1	0	0 to 15	000000H-0FFFFH	1MB	Lower 1/32
0	1	0	1	1	0 to 31	000000H-1FFFFH	2MB	Lower 1/16
0	1	1	0	0	0 to 63	000000H-3FFFFFH	4MB	Lower 1/8
0	1	1	0	1	0 to 127	000000H-7FFFFH	8MB	Lower 1/4
0	1	1	1	0	0 to 255	000000H-0FFFFFH	16MB	Lower 1/2
Х	Х	1	1	1	0 to 511	000000H-1FFFFFFH	32MB	ALL
1	0	0	0	1	511	1FFF000H-1FFFFFFH	4KB	Top Block
1	0	0	1	0	511	1FFE000H-1FFFFFFH	8KB	Top Block
1	0	0	1	1	511	1FFC000H-1FFFFFFH	16KB	Top Block
1	0	1	0	Х	511	1FF8000H-1FFFFFFH	32KB	Top Block
1	0	1	1	0	511	1FF8000H-1FFFFFFH	32KB	Top Block
1	1	0	0	1	0	000000H-000FFFH	4KB	Bottom Block
1	1	0	1	0	0	000000H-001FFFH	8KB	Bottom Block
1	1	0	1	1	0	000000H-003FFFH	16KB	Bottom Block
1	1	1	0	Х	0	000000H-007FFFH	32KB	Bottom Block

Table1. GD25LB256D Protected area size (CMP=0)



GigaD	S evice	1.8V Dua	GD	25LB256D				
1	1	1	1	0	0	000000H-007FFFH	32KB	Bottom Block

	Table1a. GD25LB256D Protected area size (CMP=1)											
;	Status F	Register	Conten	t		Memory Content						
BP4	BP3	BP2	BP1	BP0	Blocks	Addresses	Density	Portion				
Х	Х	0	0	0	0 to 511	000000H-1FFFFFH	ALL	ALL				
0	0	0	0	1	0 to 503	000000H-1F7FFFFH	32256KB	Lower 63/64				
0	0	0	1	0	0 to 494	000000H-1EFFFFFH	31MB	Lower 31/32				
0	0	0	1	1	0 to 478	000000H-1DFFFFFH	30MB	Lower 15/16				
0	0	1	0	0	0 to 446	000000H-1BFFFFFH	28MB	Lower 7/8				
0	0	1	0	1	0 to 383	000000H-17FFFFH	24MB	Lower 3/4				
0	0	1	1	0	0 to 254	000000H-0FFFFFH	16MB	Lower 1/2				
0	1	0	0	1	8 to 511	080000H-1FFFFFFH	32256KB	Upper 63/64				
0	1	0	1	0	16 to 511	100000H-1FFFFFH	31MB	Upper 31/32				
0	1	0	1	1	32 to 511	200000H-1FFFFFFH	30MB	Upper 15/16				
0	1	1	0	0	64 to 511	400000H-1FFFFFH	28MB	Upper 7/8				
0	1	1	0	1	128 to 511	800000H-1FFFFFFH	24MB	Upper 3/4				
0	1	1	1	0	256 to 511	1000000H-1FFFFFH	16MB	Upper 1/2				
Х	Х	1	1	1	NONE	NONE	NONE	NONE				
1	0	0	0	1	0 to 511	000000H-1FFEFFFH	32764KB	L-4095/4096				
1	0	0	1	0	0 to 511	000000H-1FFDFFFH	32760KB	L-2047/2048				
1	0	0	1	1	0 to 511	000000H-1FFBFFFH	32752KB	L-1023/1024				
1	0	1	0	Х	0 to 511	000000H-1FF7FFFH	32736KB	L-511/512				
1	0	1	1	0	0 to 511	000000H-1FF7FFFH	32736KB	L-511/512				
1	1	0	0	1	0 to 511	001000H-1FFFFFFH	32764KB	U-4095/4096				
1	1	0	1	0	0 to 511	002000H-1FFFFFFH	32760KB	U-2047/2048				
1	1	0	1	1	0 to 511	004000H-1FFFFFFH	32752KB	U-1023/1024				
1	1	1	0	Х	0 to 511	008000H-1FFFFFH	32736KB	U-511/512				
1	1	1	1	0	0 to 511	008000H-1FFFFFH	32736KB	U-511/512				



6. STATUS REGISTER

S15	S14	S13	S12	S11	S10	S9	S8
SUS1	СМР	LB3	LB2	EN4B	SUS2	QE	SRP1
E							
S7	S6	S5	S4	S 3	S2	S1	S0
SRP0	BP4	BP3	BP2	BP1	BP0	WEL	WIP

The status and control bits of the Status Register are as follows:

WIP bit.

The Write in Progress (WIP) bit indicates whether the memory is busy in program/erase/write status register progress. When WIP bit sets to 1, means the device is busy in program/erase/write status register progress, when WIP bit sets 0, means the device is not in program/erase/write status register progress.

WEL bit.

The Write Enable Latch (WEL) bit indicates the status of the internal Write Enable Latch. When set to 1 the internal Write Enable Latch is set, when set to 0 the internal Write Enable Latch is reset and no Write Status Register, Program or Erase command is accepted.

BP4, BP3, BP2, BP1, BP0 bits.

The Block Protect (BP4, BP3, BP2, BP1, and BP0) bits are non-volatile. They define the size of the area to be software protected against Program and Erase commands. These bits are written with the Write Status Register (WRSR) command. When the Block Protect (BP4, BP3, BP2, BP1, BP0) bits are set to 1, the relevant memory area (as defined in Table1).becomes protected against Page Program (PP), Sector Erase (SE) and Block Erase (BE) commands. The Chip Erase (CE) command is executed, if if the Block Protect (BP2, BP1, and BP0) bits are 0 and CMP=0 or the Block Protect (BP2, BP1, and BP0) bits are 1 and CMP=1.

SRP1, SRP0 bits.

The Status Register Protect (SRP1 and SRP0) bits are non-volatile Read/Write bits in the status register. The SRP bits control the method of write protection: software protection, power supply lock-down or one time programmable protection.

SRP1	SRP0	Status Register	Description			
0	0	Software Protected	The Status Register can be written to after a Write Enable command,			
0	0	Soliware Protected	WEL=1.(Default)			
1	0	Power Supply Lock-	Status Register is protected and cannot be written to again until the			
'	0			0	Down ⁽¹⁾⁽²⁾	next Power-Down, Power-Up cycle.
1	1	One Time Program ⁽²⁾	Status Register is permanently protected and cannot be written to.			

NOTE:

1. When SRP1, SRP0= (1, 0), a Power-Down, Power-Up cycle will change SRP1, SRP0 to (0, 0) state.

2. This feature is available on special order. Please contact GigaDevice for details.





The Quad Enable (QE) bit is a non-volatile read only bit which allows Quad operation. The default value of QE bit is 1, and it cannot be changed so that the Quad IO2 and IO3 pins are enabled all the time.

LB2, LB3 bits.

The LB2, LB3 bits are non-volatile One Time Program (OTP) bits in Status Register (S12-S13) that provide the write protect control and status to the Security Registers. The default state of LB2-LB3 are 0, the security registers are unlocked. The LB2-LB3 bits can be set to 1 individually using the Write Register instruction. The LB2-LB3 bits are One Time Programmable, once they are set to 1, the Security Registers will become read-only permanently.

CMP bit

The CMP bit is a non-volatile Read/Write bit in the Status Register (S14). It is used in conjunction with the BP4-BP0 bits to provide more flexibility for the array protection. Please see the Status registers Memory Protection table for details. The default setting is CMP=0.

SUS1, SUS2 bits

The SUS1 and SUS2 bits are read only bits in the status register (S15 and S10) that are set to 1 after executing an Erase/Program Suspend (75H) command (The Erase Suspend will set the SUS1 to 1, and the Program Suspend will set the SUS2 to 1). The SUS1 and SUS2 bit are cleared to 0 by Erase/Program Resume (7AH) command, software reset (66H+99H) command as well as a power-down, power-up cycle.

EN4B bit

The EN4B bit is a volatile read only bit in the status register (S11) that is set to 1 after executing the Enable 4-byte Mode command, and cleared to 0 (default) by the Disable 4-byte Mode command as well as a power-down, power-up cycle.





7. COMMANDS DESCRIPTION

All commands, addresses and data are shifted in and out of the device, beginning with the most significant bit on the first rising edge of SCLK after CS# is driven low. Then, the one-byte command code must be shifted in to the device, with the most significant bit first on SI, and each bit is latched on the rising edges of SCLK.

See Table2, every command sequence starts with a one-byte command code. Depending on the command, this might be followed by address bytes, or by data bytes, or by both or none. CS# must be driven high after the last bit of the command sequence has been completed. For the command of Read, Fast Read, Read Status Register or Release from Deep Power-Down, and Read Device ID, the shifted-in command sequence is followed by a data-out sequence. All read instruction can be completed after any bit of the data-out sequence is being shifted out, and then CS# must be driven high to return to deselected status.

For the command of Page Program, Sector Erase, Block Erase, Chip Erase, Write Status Register, Write Enable, Write Disable or Deep Power-Down command, CS# must be driven high exactly at a byte boundary, otherwise the command is rejected, and is not executed. That is CS# must be driven high when the number of clock pulses after CS# being driven low is an exact multiple of eight. For Page Program, if at any time the input byte is not a full byte, nothing will happen and WEL will not be reset.

Command Name	Byte 1	Byte 2	Byte 3	Byte 4	Byte 5	Byte 6	n-Bytes
Write Enable	06H						
Write Disable	04H						
Volatile SR	50H						
Write Enable							
Read Status Register	05H	(S7-S0)					(continuous)
Read Status Register-1	35H	(S15-S8)					(continuous)
Write Status Register	01H	S7-S0	S15-S8				
Read Data	03H	A23-A16	A15-A8	A7-A0	(D7-D0)	(Next byte)	(continuous)
Fast Read	0BH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	(continuous)
Dual Output	3BH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0) ⁽¹⁾	(continuous)
Fast Read							
Dual I/O	BBH	A23-A8 ⁽²⁾	A7-A0	(D7-D0) ⁽¹⁾			(continuous)
Fast Read			M7-M0 ⁽²⁾				
Quad Output	6BH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0) ⁽³⁾	(continuous)
Fast Read							
Quad I/O	EBH	A23-A0	dummy ⁽⁵⁾	(D7-D0) ⁽³⁾			(continuous)
Fast Read		M7-M0 ⁽⁴⁾					
Quad I/O Word	E7H	A23-A0	dummy ⁽⁶⁾	(D7-D0) ⁽³⁾			(continuous)
Fast Read ⁽⁷⁾		M7-M0 ⁽⁴⁾					
Page Program	02H	A23-A16	A15-A8	A7-A0	D7-D0	Next byte	
Quad Page Program	32H	A23-A16	A15-A8	A7-A0	D7-D0		
Sector Erase	20H	A23-A16	A15-A8	A7-A0			
Block Erase(32K)	52H	A23-A16	A15-A8	A7-A0			
Block Erase(64K)	D8H	A23-A16	A15-A8	A7-A0			
Chip Erase	C7/60H						
Enable QPI	38H						
Enable Reset	66H						
Reset	99H						
Set Burst with Wrap	77H	W6-W4					
Program/Erase	75H						
Suspend							
Program/Erase Resume	7AH						

Table2. Commands (Standard/Dual/Quad SPI) (3-byte mode)





1.8V Uniform Sector Dual and Quad Serial Flash

Release From Deep	ABH	dummy	dummy	dummy	(ID7-ID0)		(continuous)
Power-Down, And							(,
Read Device ID							
Release From Deep	ABH						
Power-Down							
Deep Power-Down	B9H						
Manufacturer/ Device ID	90H	dummy	dummy	00H	(M7-M0)	(ID7-ID0)	(continuous)
Manufacturer/ Device ID by Dual I/O	92H	A23-A8	A7-A0, M[7:0]	(M7-M0) (ID7-ID0)			(continuous)
Manufacturer/ Device ID by Quad I/O	94H	A23-A0, M[7:0]	dummy	(M7-M0) (ID7-ID0)			(continuous)
Read Identification	9FH	(M7-M0)	(ID15-ID8)	(ID7-ID0)			(continuous)
Read Serial Flash Discoverable Parameter ⁽¹⁰⁾	5AH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	(continuous)
Read Unique ID	4BH	00H	00H	00Н	dummy	(UID7- UID0)	(continuous)
Erase Security Registers ⁽⁸⁾	44H	A23-A16	A15-A8	A7-A0			
Program Security Registers ⁽⁸⁾	42H	A23-A16	A15-A8	A7-A0	D7-D0	D7-D0	
Read Security Registers ⁽⁸⁾	48H	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	
Enable 4-byte Mode	B7H						
Disable 4-byte Mode	E9H						

Table2.1. Commands (Standard/Dual/Quad SPI) (4-byte mode)

		-			-		
Command Name	Byte 1	Byte 2	Byte 3	Byte 4	Byte 5	Byte 6	Byte 7
Read Data	03H	A31-A24	A23-A16	A15-A8	A7-A0	(D7-D0)	(Next byte)
Fast Read	0BH	A31-A24	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)
Dual Output Fast Read	3BH	A31-A24	A23-A16	A15-A8	A7-A0	dummy	(D7-D0) ⁽¹⁾
Dual I/O Fast Read	BBH	A31-A24	A23-A8 ⁽²⁾	A7-A0 M7-M0 ⁽²⁾	(D7-D0) ⁽¹⁾		
Quad Output Fast Read	6BH	A31-A24	A23-A16	A15-A8	A7-A0	dummy	(D7-D0) ⁽³⁾
Quad I/O Fast Read	EBH	A31-A0	M7-M0 ⁽⁴⁾	dummy ⁽⁵⁾	(D7-D0) ⁽³⁾		
Quad I/O Word Fast Read ⁽⁷⁾	E7H	A31-A0	M7-M0 ⁽⁴⁾	dummy ⁽⁶⁾	(D7-D0) ⁽³⁾		
Page Program	02H	A31-A24	A23-A16	A15-A8	A7-A0	D7-D0	Next byte
Quad Page Program	32H	A31-A24	A23-A16	A15-A8	A7-A0	D7-D0	
Sector Erase	20H	A31-A24	A23-A16	A15-A8	A7-A0		
Block Erase(32K)	52H	A31-A24	A23-A16	A15-A8	A7-A0		
Block Erase(64K)	D8H	A31-A24	A23-A16	A15-A8	A7-A0		





1.8V Uniform Sector Dual and Quad Serial Flash

GD25LB256D

Table2a. Commands (QPI) (3-byte mode)

Command Name	Byte 1	Byte 2	Byte 3	Byte 4	Byte 5	Byte 6	Byte7
Clock Number	(0,1)	(2,3)	(4,5)	(6,7)	(8,9)	(10,11)	(12,13)
Write Enable	06H						
Volatile SR Write Enable	50H						
Write Disable	04H						
Read Status Register	05H	(S7-S0)					
Read Status Register-1	35H	(S15-S8)					
Read Status Register-2	15H	(S1-S0)					
Write Status Register	01H	S7-S0	S15-S8				
Page Program	02H	A23-A16	A15-A8	A7-A0	D7-D0	Next byte	
Sector Erase	20H	A23-A16	A15-A8	A7-A0			
Block Erase(32K)	52H	A23-A16	A15-A8	A7-A0			
Block Erase(64K)	D8H	A23-A16	A15-A8	A7-A0			
Chip Erase	C7/60H						
Program/Erase Suspend	75H						
Program/Erase Resume	7AH						
Deep Power-Down	B9H						
Set Read Parameters	COH	P7-P0					
Fast Read	0BH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	
Burst Read with Wrap	0CH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	
Burst Read with Wrap for Lower 128Mb (A24=0)	8CH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	
Burst Read with Wrap for Higher 128Mb (A24=1)	8DH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	
Quad I/O Fast Read	EBH	A23-A16	A15-A8	A7-A0	M7-M0	dummy	(D7-D0)
Release From Deep Power-Down, And Read Device ID	ABH	dummy	dummy	dummy	(ID7-ID0)		
Manufacturer/ Device ID	90H	dummy	dummy	00H	(M7-M0)	(ID7-ID0)	
Read Identification	9FH	(M7-M0)	(ID15- ID8)	(ID7-ID0)			
Read Serial Flash Discoverable Parameter ⁽¹⁰⁾	5AH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	
Disable QPI	FFH						
Enable Reset	66H						
Reset	99H						
Enable 4-byte Mode	B7H						
Disable 4-byte Mode	E9H						

				. ,				
Command Name	Byte 1	Byte 2	Byte 3	Byte 4	Byte 5	Byte 6	Byte7	Byte8
Clock Number	(0,1)	(2,3)	(4,5)	(6,7)	(8,9)	(10,11)	(12,13)	(14,15)
Page Program	02H	A31-A24	A23-A16	A15-A8	A7-A0	D7-D0	Next byte	
Sector Erase	20H	A31-A24	A23-A16	A15-A8	A7-A0			
Block Erase(32K)	52H	A31-A24	A23-A16	A15-A8	A7-A0			
Block Erase(64K)	D8H	A31-A24	A23-A16	A15-A8	A7-A0			
Fast Read	0BH	A31-A24	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	
Burst Read with Wrap	0CH	A31-A24	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	
Quad I/O Fast Read	EBH	A31-A24	A23-A16	A15-A8	A7-A0	M7-M0	dummy	(D7-D0)





```
NOTE:
1. Dual Output data
       IO0 = (D6, D4, D2, D0)
       IO1 = (D7, D5, D3, D1)
2. Dual Input Address
       IO0 = A22, A20, A18, A16, A14, A12, A10, A8 A6, A4, A2, A0, M6, M4, M2, M0
       IO1 = A23, A21, A19, A17, A15, A13, A11, A9 A7, A5, A3, A1, M7, M5, M3, M1
3. Quad Output Data
       IO0 = (D4, D0, ....)
       IO1 = (D5, D1, ....)
       IO2 = (D6, D2, ....)
       IO3 = (D7, D3, ....)
4. Quad Input Address
       IO0 = A20, A16, A12, A8, A4, A0, M4, M0
       IO1 = A21, A17, A13, A9, A5, A1, M5, M1
       IO2 = A22, A18, A14, A10, A6, A2, M6, M2
       IO3 = A23, A19, A15, A11, A7, A3, M7, M3
5. Fast Read Quad I/O Data
       IO0 = (x, x, x, x, D4, D0,...)
       IO1 = (x, x, x, x, D5, D1,...)
       IO2 = (x, x, x, x, D6, D2,...)
       IO3 = (x, x, x, x, D7, D3,...)
6. Fast Word Read Quad I/O Data
       IO0 = (x, x, D4, D0,...)
       IO1 = (x, x, D5, D1, ...)
       IO2 = (x, x, D6, D2,...)
       IO3 = (x, x, D7, D3,...)
7. Fast Word Read Quad I/O Data: the lowest address bit must be 0.
8. Security Registers Address:
          Security Register2: A23-A16=00H, A15-A9=0010000b, A8-A0=Byte Address;
          Security Register3: A23-A16=00H, A15-A9=0011000b, A8-A0=Byte Address.
9. QPI Command, Address, Data input/output format:
        CLK #0 1
                        2
                            3
                                  4 5
                                             6 7
                                                      8 9 10 11
        IO0= C4, C0, A20, A16, A12, A8, A4, A0, D4, D0, D4, D0,
        IO1= C5, C1, A21, A17, A13, A9, A5, A1, D5, D1, D5, D1
        IO2= C6, C2, A22, A18, A14, A10, A6, A2, D6, D2, D6, D2
        IO3= C7, C3, A23, A19, A15, A11, A7, A3, D7, D3, D7, D3
10. Read Serial Flash Discoverable Parameter (SFDP) command is available on special order. Please contact GigaDevice
if this function is needed.
```

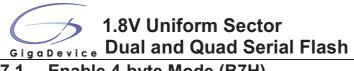


Table of ID Definitions:

GD25LB256D

Operation Code	M7-M0	ID15-ID8	ID7-ID0
9FH	C8	60	19
90H	C8		18
ABH			18

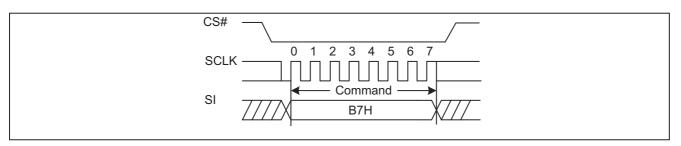


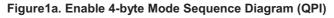


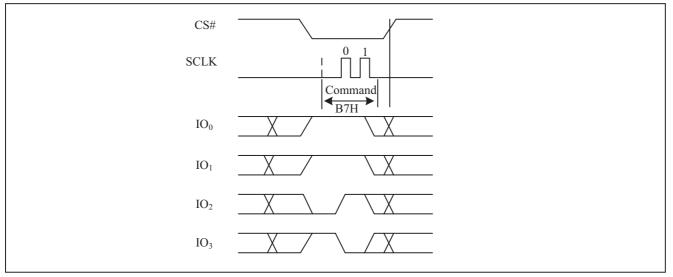
7.1. Enable 4-byte Mode (B7H)

The Enable 4-byte Mode command enables accessing the address length of 32-bit for the memory area of the higher density (larger than 128Mb). The GD25LB256D default is in 24-bit address mode. After sending the Enable 4-byte Mode command, the EN4B bit (S11) will be set to 1 to indicate the 4-byte address mode has been enabled. Once the 4-byte address mode is enabled, the address length becomes 32-bit instead of the default 24 bit. The Disable 4-byte mode or Reset or Power-off will disable 4-byte mode. In the 4-byte mode, A31-A25 are don't care.

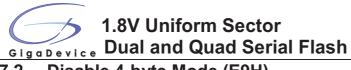
Figure1. Enable 4-byte Mode Sequence Diagram











7.2. Disable 4-byte Mode (E9H)

The Disable 4-byte Mode command is executed to exit the 4-byte address mode and return to the default 3-byte address mode. After sending the Disable 4-byte Mode command, the EN4B bit (S11) will be clear to be 0 to indicate the 4-byte address mode has been disabled, and then the address length will return to 24-bit.



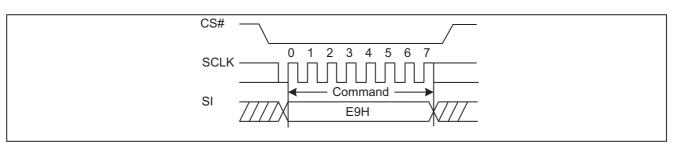
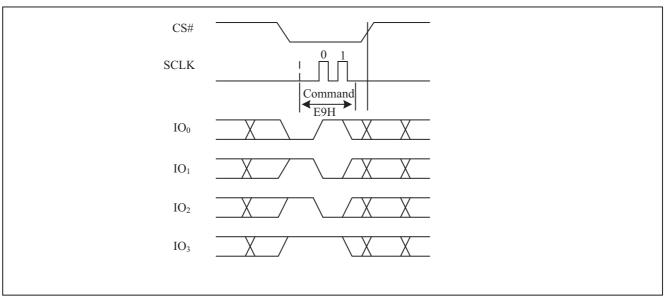
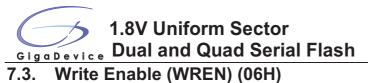


Figure2a. Disable 4-byte Mode Sequence Diagram (QPI)







The Write Enable (WREN) command is for setting the Write Enable Latch (WEL) bit. The Write Enable Latch (WEL) bit must be set prior to even Page Program (PP). Sector Frace (SE), Plack Frace (RE), Chip Frace (CE), Write Status

bit must be set prior to every Page Program (PP), Sector Erase (SE), Block Erase (BE), Chip Erase (CE), Write Status Register (WRSR) and Erase/Program Security Registers command. The Write Enable (WREN) command sequence: CS# goes low \rightarrow sending the Write Enable command \rightarrow CS# goes high.

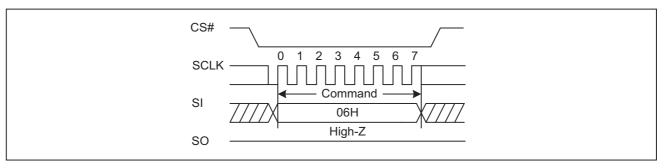
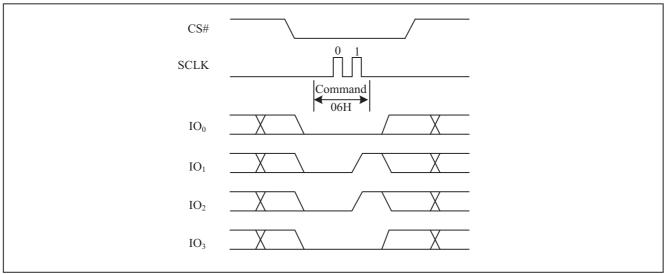
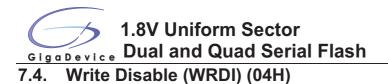


Figure3. Write Enable Sequence Diagram









The Write Disable command is for resetting the Write Enable Latch (WEL) bit. The Write Disable command sequence: CS# goes low \rightarrow Sending the Write Disable command \rightarrow CS# goes high. The WEL bit is reset by following condition: Powerup and upon completion of the Write Status Register, Page Program, Sector Erase, Block Erase, Chip Erase, Erase/Program Security Registers and Reset commands.

Figure4. Write Disable Sequence Diagram

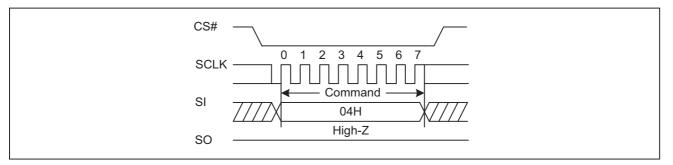
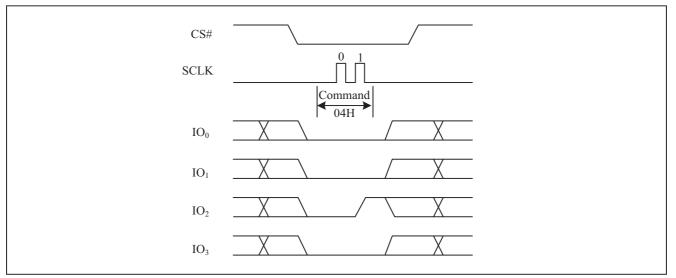
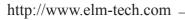
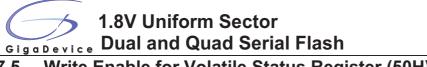


Figure4a. Write Disable Sequence Diagram (QPI)









7.5. Write Enable for Volatile Status Register (50H)

The non-volatile Status Register bits can also be written to as volatile bits. This gives more flexibility to change the system configuration and memory protection schemes quickly without waiting for the typical non-volatile bit write cycles or affecting the endurance of the Status Register non-volatile bits. The Write Enable for Volatile Status Register command must be issued prior to a Write Status Register command, and any other commands can't be inserted between them. Otherwise, Write Enable for Volatile Status Register command will not set the Write Enable for Volatile Status Register command will not set the Write Enable Latch bit, it is only valid for the Write Status Register command to change the volatile Status Register bit values.

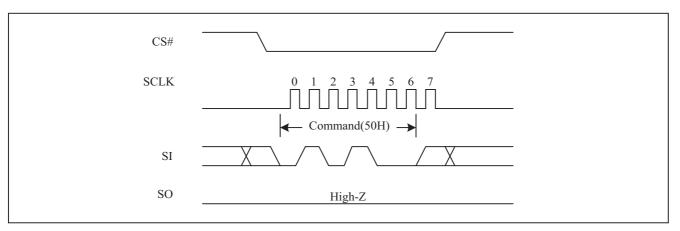
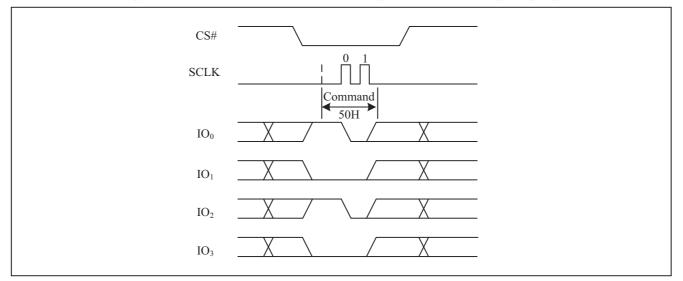
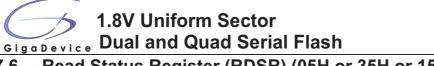


Figure 5. Write Enable for Volatile Status Register Sequence Diagram

Figure5a. Write Enable for Volatile Status Register Sequence Diagram (QPI)







7.6. Read Status Register (RDSR) (05H or 35H or 15H)

The Read Status Register (RDSR) command is for reading the Status Register. The Status Register may be read at any time, even while a Program, Erase or Write Status Register cycle is in progress. When one of these cycles is in progress, it is recommended to check the Write in Progress (WIP) bit before sending a new command to the device. It is also possible to read the Status Register continuously. For command code "05H" / "35H", the SO will output Status Register bits S7~S0 / S15-S8. The command code "15H" only supports the QPI mode, the I/O0 will output Status Register S1-S0. (For 120MHz Frequency, the 15H will better than 05H to check the WIP bit)

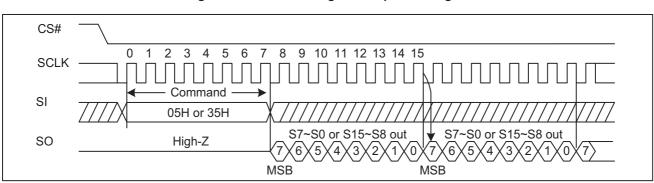
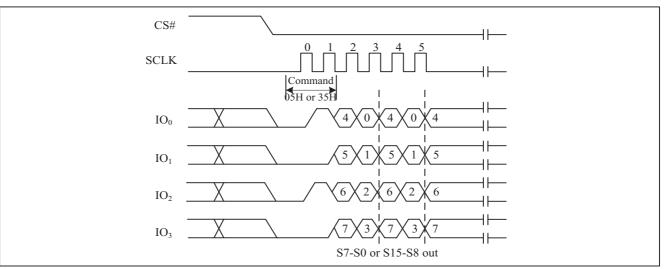
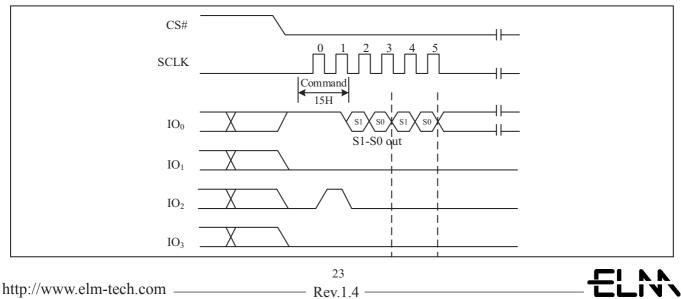


Figure6. Read Status Register Sequence Diagram









1.8V Uniform SectorGigaDeviceDual and Quad Serial Flash7.7.Write Status Register (WRSR) (01H)

The Write Status Register (WRSR) command allows new values to be written to the Status Register. Before it can be accepted, a Write Enable (WREN) command must previously have been executed. After the Write Enable (WREN) command has been decoded and executed, the device sets the Write Enable Latch (WEL).

The Write Status Register (WRSR) command has no effect on S15, S11, S10, S1 and S0 of the Status Register. CS# must be driven high after the eighth or sixteen bit of the data byte has been latched in. If not, the Write Status Register (WRSR) command is not executed. If CS# is driven high after eighth bit of the data byte, the CMP bit will be cleared to 0 in SPI mode, while only CMP will be cleared to 0 in QPI mode. As soon as CS# is driven high, the self-timed Write Status Register cycle (whose duration is tw) is initiated. While the Write Status Register cycle is in progress, the Status Register may still be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Write Status Register cycle, and is 0 when it is completed. When the cycle is completed, the Write Enable Latch (WEL) is reset.

The Write Status Register (WRSR) command allows the user to change the values of the Block Protect (BP4, BP3, BP2, BP1, and BP0) bits, to define the size of the area that is to be treated as read-only, as defined in Table1.

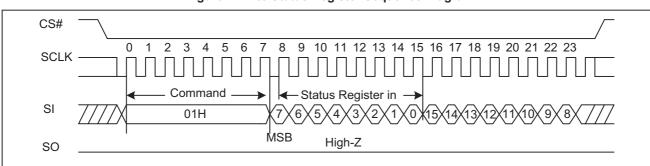
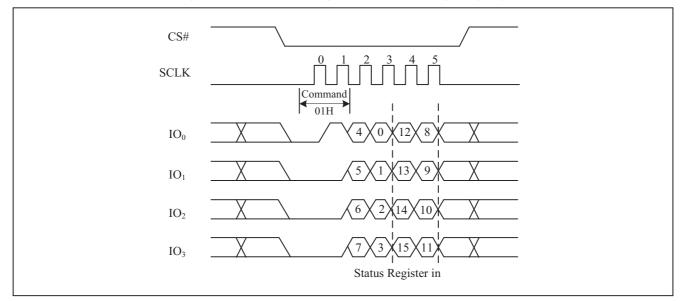
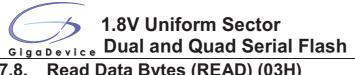


Figure7. Write Status Register Sequence Diagram

Figure7a. Write Status Register Sequence Diagram (QPI)



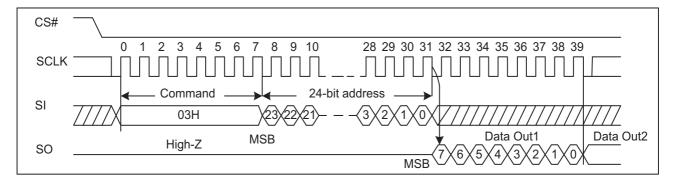


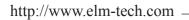


7.8. Read Data Bytes (READ) (03H)

The Read Data Bytes (READ) command is followed by a 3-byte address (A23-A0) or a 4-byte address (A31-A0), and each bit is latched-in on the rising edge of SCLK. Then the memory content, at that address, is shifted out on SO, and each bit is shifted out, at a Max frequency f_R, on the falling edge of SCLK. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. The default read mode is 3-byte address mode, and the lower 128Mbit can be read with a single Read Data Byte (03H) command. By entering 4-byte address mode, or to set EN4B (S11) bit to 1, the higher 128Mbit can be read with a single Read Data Byte (03H) command. Any Read Data Bytes (READ) command, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.





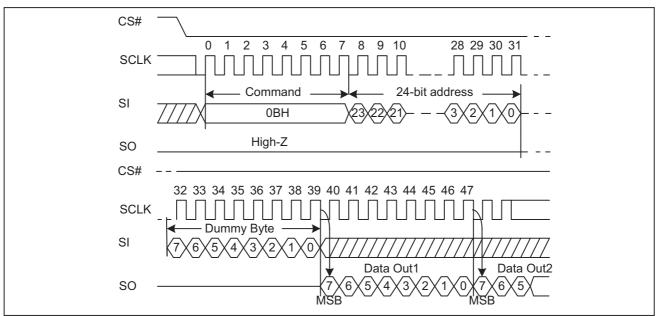




1.8V Uniform Sector GigaDevice Dual and Quad Serial Flash A Read Data Bytes at Higher Speed (East Read) (0Bb

7.9. Read Data Bytes at Higher Speed (Fast Read) (0BH)

The Read Data Bytes at Higher Speed (Fast Read) command is for quickly reading data out. It is followed by a 3-byte address (A23-A0) or a 4-byte address (A31-A0) and a dummy byte, and each bit is latched-in on the rising edge of SCLK. Then the memory content, at that address, is shifted out on SO, and each bit is shifted out, at a Max frequency f_C, on the falling edge of SCLK. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. The default read mode is 3-byte address mode, and the lower 128Mbit can be read with a single Read Data Byte at Higher Speed (0BH) command. By entering 4-byte address mode, or to set EN4B (S11) bit to 1, the higher 128Mbit can be read with a single Read Data Byte at Higher speed (0BH) command.









Fast Read (0BH) in QPI mode

The Fast Read command is also supported in QPI mode. In QPI mode, the number of dummy clocks is configured by the "Set Read Parameters (C0H)" command to accommodate a wide range application with different needs for either maximum Fast Read frequency or minimum data access latency. Depending on the Read Parameter Bits P[5:4] setting, the number of dummy clocks can be configured as either 4/6/8/8.

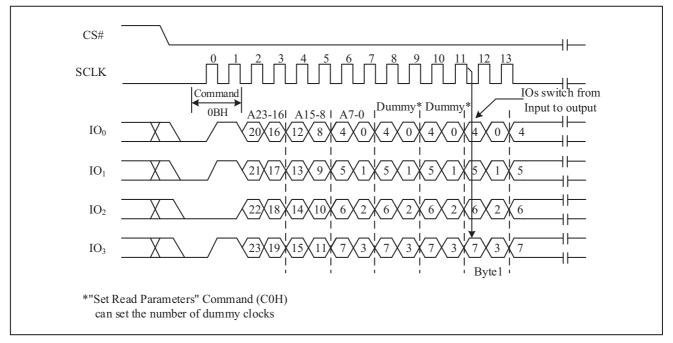
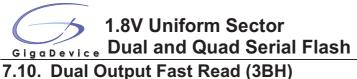


Figure9a. Read Data Bytes at Higher Speed Sequence Diagram (QPI)





7.10. Dual Output Fast Read (3BH)

The Dual Output Fast Read command is followed by 3-byte address (A23-A0) or a 4-byte address (A31-A0)and a dummy byte, and each bit is latched in on the rising edge of SCLK, then the memory contents are shifted out 2-bit per clock cycle from SI and SO. The command sequence is shown in followed Figure10. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. he default read mode is 3-byte address mode, and the lower 128Mbit can be read with a single Dual Output Fast Read (3BH) command. By entering 4-byte address mode, or to set EN4B (S11) bit to 1, the higher 128Mbit can be read with a single Dual Output Fast Read (3BH) command.

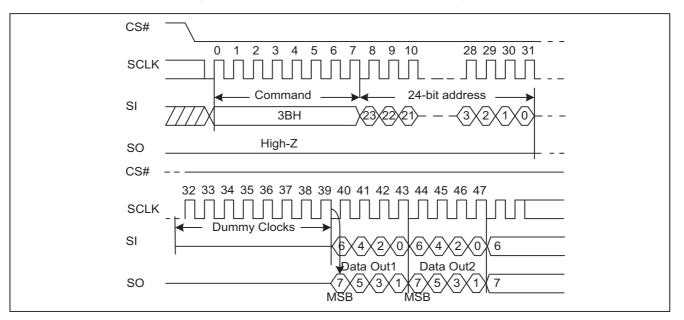
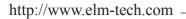
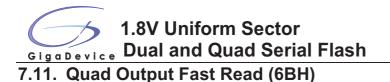


Figure10. Dual Output Fast Read Sequence Diagram







The Quad Output Fast Read command is followed by 3-byte address (A23-A0) or a 4-byte address (A31-A0) and a dummy byte, and each bit is latched in on the rising edge of SCLK, then the memory contents are shifted out 4-bit per clock cycle from IO3, IO2, IO1 and IO0. The command sequence is shown in followed Figure11. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. The default read mode is 3-byte address mode, and the lower 128Mbit can be read with a single Quad Output Fast Read (6BH) command. By entering 4-byte address mode, or to set EN4B (S11) bit to 1, the higher 128Mbit can be read with a single Quad Output Fast Read (6BH) command.

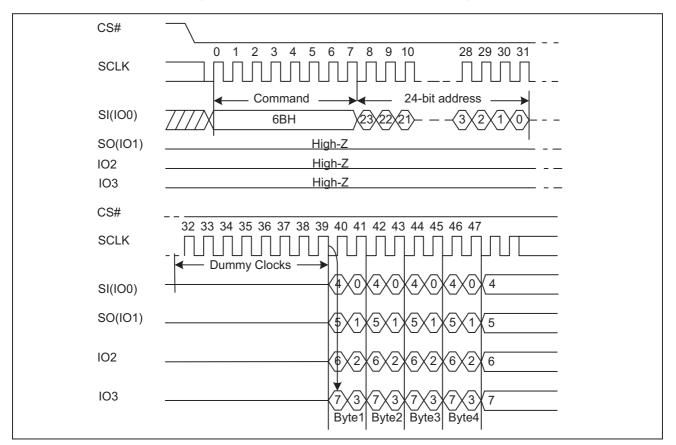


Figure11. Quad Output Fast Read Sequence Diagram



1.8V Uniform SectorGigaDeviceDual and Quad Serial Flash7.12. Dual I/O Fast Read (BBH)

The Dual I/O Fast Read command is similar to the Dual Output Fast Read command but with the capability to input the 3-byte address (A23-0) or a 4-byte address (A31-A0) and a "Continuous Read Mode" byte 2-bit per clock by SI and SO, and each bit is latched in on the rising edge of SCLK, then the memory contents are shifted out 2-bit per clock cycle from SI and SO. The command sequence is shown in followed Figure 12. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. The default read mode is 3-byte address mode, and the lower 128Mbit can be read with a single Dual I/O Fast Read (BBH) command. By entering 4-byte address mode, or to set EN4B (S11) bit to 1, the higher 128Mbit can be read with a single Dual I/O Fast Read (BBH) command.

Dual I/O Fast Read with "Continuous Read Mode"

The Dual I/O Fast Read command can further reduce command overhead through setting the "Continuous Read Mode" bits (M7-0) after the input 3-byte address (A23-A0) or a 4-byte address (A31-A0). If the "Continuous Read Mode" bits (M5-4) = (1, 0), then the next Dual I/O Fast Read command (after CS# is raised and then lowered) does not require the BBH command code. The command sequence is shown in followed Figure 12a. If the "Continuous Read Mode" bits (M5-4) do not equal (1, 0), the next command requires the first BBH command code, thus returning to normal operation.

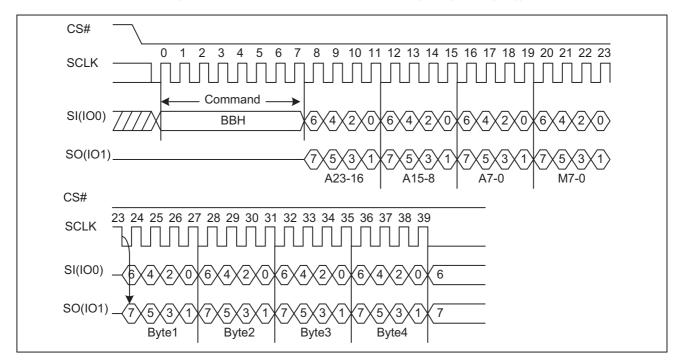


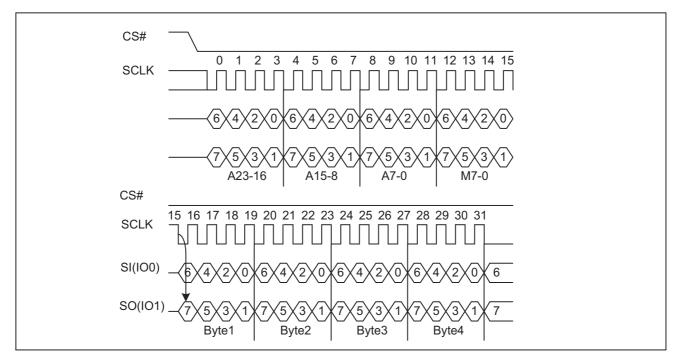
Figure12. Dual I/O Fast Read Sequence Diagram (M5-4≠ (1, 0))

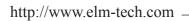




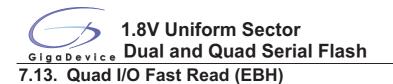
1.8V Uniform Sector Dual and Quad Serial Flash

Figure12a. Dual I/O Fast Read Sequence Diagram (M5-4= (1, 0))









The Quad I/O Fast Read command is similar to the Dual I/O Fast Read command but with the capability to input the 3-byte address (A23-0) or a 4-byte address (A31-A0) and a "Continuous Read Mode" byte and 4-dummy clock 4-bit per clock by IO0, IO1, IO3, IO4, and each bit is latched in on the rising edge of SCLK, then the memory contents are shifted out 4-bit per clock cycle from IO0, IO1, IO2, IO3. The command sequence is shown in followed Figure 13. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. The default read mode is 3-byte address mode, and the lower 128Mbit can be read with a single Quad I/O Fast Read (EBH) command. By entering 4-byte address mode, or to set EN4B (S11) bit to 1, the higher 128Mbit can be read with a single Quad I/O Fast Read (EBH) command.

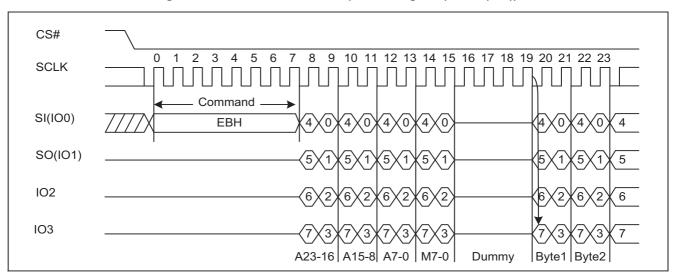


Figure13. Quad I/O Fast Read Sequence Diagram (M5-4≠ (1, 0))

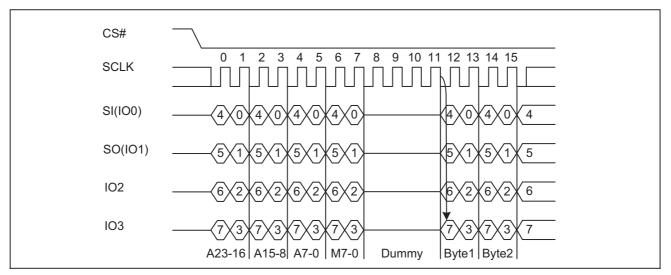




Quad I/O Fast Read with "Continuous Read Mode"

The Quad I/O Fast Read command can further reduce command overhead through setting the "Continuous Read Mode" bits (M7-0) after the input 3-byte address (A23-A0) or a 4-byte address (A31-A0). If the "Continuous Read Mode" bits (M5-4) = (1, 0), then the next Quad I/O Fast Read command (after CS# is raised and then lowered) does not require the EBH command code. The command sequence is shown in followed Figure 13a. If the "Continuous Read Mode" bits (M5-4) do not equal to (1, 0), the next command requires the first EBH command code, thus returning to normal operation.





Note: The device default is in 24-bit address mode. For 4-byte mode, the address length becomes 32-bit.

Quad I/O Fast Read with "8/16/32/64-Byte Wrap Around" in Standard SPI mode

The Quad I/O Fast Read command can be used to access a specific portion within a page by issuing "Set Burst with Wrap" (77H) commands prior to EBH. The "Set Burst with Wrap" (77H) command can either enable or disable the "Wrap Around" feature for the following EBH commands. When "Wrap Around" is enabled, the data being accessed can be limited to either an 8/16/32/64-byte section of a 256-byte page. The output data starts at the initial address specified in the command, once it reaches the ending boundary of the 8/16/32/64-byte section, the output will wrap around the beginning boundary automatically until CS# is pulled high to terminate the command.

The Burst with Wrap feature allows applications that use cache to quickly fetch a critical address and then fill the cache afterwards within a fixed length (8/16/32/64-byte) of data without issuing multiple read commands. The "Set Burst with Wrap" command allows three "Wrap Bits" W6-W4 to be set. The W4 bit is used to enable or disable the "Wrap Around" operation while W6-W5 is used to specify the length of the wrap around section within a page.





Quad I/O Fast Read (EBH) in QPI mode

The Quad I/O Fast Read command is also supported in QPI mode. See Figure14b. In QPI mode, the number of dummy clocks is configured by the "Set Read Parameters (C0H)" command to accommodate a wide range application with different needs for either maximum Fast Read frequency or minimum data access latency. Depending on the Read Parameter Bits P[5:4] setting, the number of dummy clocks can be configured as either 4/6/8/8. In QPI mode, the "Continuous Read Mode" bits M7-M0 are also considered as dummy clocks. "Continuous Read Mode" feature is also available in QPI mode for Quad I/O Fast Read command. "Wrap Around" feature is not available in QPI mode, a dedicated "Burst Read with Wrap" (0CH) command must be used.

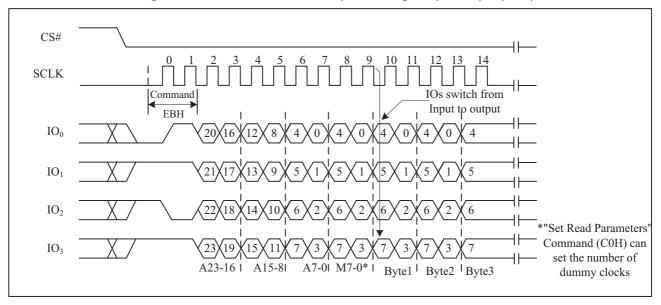
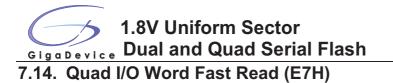


Figure13b. Quad I/O Fast Read Sequence Diagram (M5-4= (1, 0) QPI)





The Quad I/O Word Fast Read command is similar to the Quad I/O Fast Read command except that the lowest address bit (A0) must equal 0 and only 2-dummy clock. The command sequence is shown in followed Figure 14. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. The default read mode is 3-byte address mode, and the lower 128Mbit can be read with a single Quad I/O Word Fast Read (E7H) command. By entering 4-byte address mode, or to set EN4B (S11) bit to 1, the higher 128Mbit can be read with a single Quad I/O Word Fast Read (E7H) command.

Quad I/O Word Fast Read with "Continuous Read Mode"

The Quad I/O Word Fast Read command can further reduce command overhead through setting the "Continuous Read Mode" bits (M7-0) after the input 3-byte address (A23-A0) or a 4-byte address (A31-A0). If the "Continuous Read Mode" bits (M5-4) = (1, 0), then the next Quad I/O Word Fast Read command (after CS# is raised and then lowered) does not require the E7H command code. The command sequence is shown in followed Figure 14. If the "Continuous Read Mode" bits (M5-4) do not equal to (1, 0), the next command requires the first E7H command code, thus returning to normal operation.

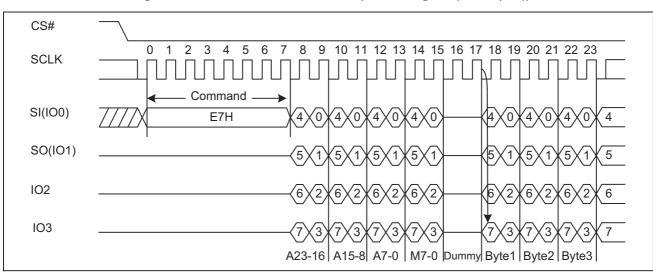


Figure14. Quad I/O Word Fast Read Sequence Diagram (M5-4≠ (1, 0))

Note: The device default is in 24-bit address mode. For 4-byte mode, the address length becomes 32-bit.

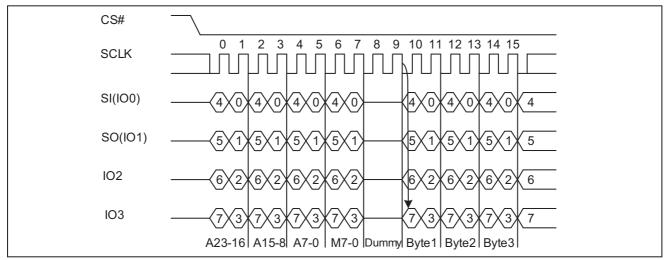


Figure14a. Quad I/O Word Fast Read Sequence Diagram (M5-4= (1, 0))



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Quad I/O Word Fast Read with "8/16/32/64-Byte Wrap Around" in Standard SPI mode

The Quad I/O Word Fast Read command can be used to access a specific portion within a page by issuing "Set Burst with Wrap" (77H) commands prior to E7H. The "Set Burst with Wrap" (77H) command can either enable or disable the "Wrap Around" feature for the following E7H commands. When "Wrap Around" is enabled, the data being accessed can be limited to either an 8/16/32/64-byte section of a 256-byte page. The output data starts at the initial address specified in the command, once it reaches the ending boundary of the 8/16/32/64-byte section, the output will wrap around the beginning boundary automatically until CS# is pulled high to terminate the command.

The Burst with Wrap feature allows applications that use cache to quickly fetch a critical address and then fill the cache afterwards within a fixed length (8/16/32/64-byte) of data without issuing multiple read commands. The "Set Burst with Wrap" command allows three "Wrap Bits" W6-W4 to be set. The W4 bit is used to enable or disable the "Wrap Around" operation while W6-W5 is used to specify the length of the wrap around section within a page.

7.15. Set Burst with Wrap (77H)

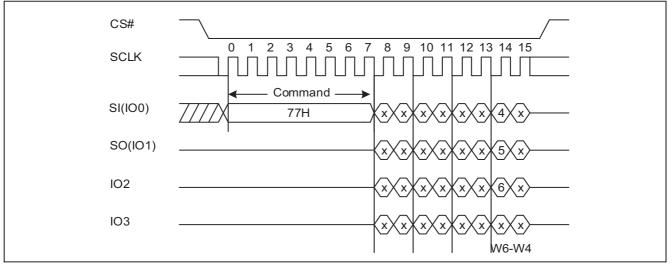
The Set Burst with Wrap command is used in conjunction with "Quad I/O Fast Read" and "Quad I/O Word Fast Read" command to access a fixed length of 8/16/32/64-byte section within a 256-byte page.

The Set Burst with Wrap command sequence: CS# goes low \rightarrow Send Set Burst with Wrap command \rightarrow Send 24 dummy bits \rightarrow Send 8 bits "Wrap bits" \rightarrow CS# goes high.

W6,W5	W 4	!=0	W4=1 (default)		
	Wrap Around	Wrap Length	Wrap Around	Wrap Length	
0, 0	Yes	8-byte	No	N/A	
0, 1	Yes	16-byte	No	N/A	
1, 0	Yes	32-byte	No	N/A	
1, 1	Yes	64-byte	No	N/A	

If the W6-W4 bits are set by the Set Burst with Wrap command, all the following "Quad I/O Fast Read" and "Quad I/O Word Fast Read" command will use the W6-W4 setting to access the 8/16/32/64-byte section within any page. To exit the "Wrap Around" function and return to normal read operation, another Set Burst with Wrap command should be issued to set W4=1. In QPI mode, the "Burst Read with Wrap (0CH)" command should be used to perform the Read Operation with "Wrap Around" feature. The Wrap Length set by W5-W6 in Standard SPI mode is still valid in QPI mode and can also be reconfigured by "Set Read Parameters (C0H) command.





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1.8V Uniform Sector Dual and Quad Serial Flash 7.16. Page Program (PP) (02H)

The Page Program (PP) command is for programming the memory. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Page Program command.

The Page Program (PP) command is entered by driving CS# Low, followed by the command code, three address bytes and at least one data byte on SI. If the 8 least significant address bits (A7-A0) are not all zero, all transmitted data that goes beyond the end of the current page are programmed from the start address of the same page (from the address whose 8 least significant bits (A7-A0) are all zero). CS# must be driven low for the entire duration of the sequence. The Page Program command sequence: CS# goes low \rightarrow sending Page Program command \rightarrow 3-byte address or 4-byte address on SI \rightarrow at least 1 byte data on SI \rightarrow CS# goes high. The command sequence is shown in Figure 16. If more than 256 bytes are sent to the device, previously latched data are discarded and the last 256 data bytes are guaranteed to be programmed correctly within the same page. If less than 256 data bytes are sent to device, they are correctly programmed at the requested addresses without having any effects on the other bytes of the same page. CS# must be driven high after the eighth bit of the last data byte has been latched in; otherwise the Page Program (PP) command is not executed.

As soon as CS# is driven high, the self-timed Page Program cycle (whose duration is t_{PP}) is initiated. While the Page Program cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Page Program cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset.

A Page Program (PP) command applied to a page which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) is not executed.

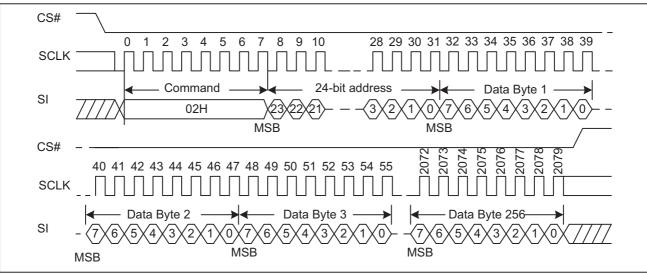


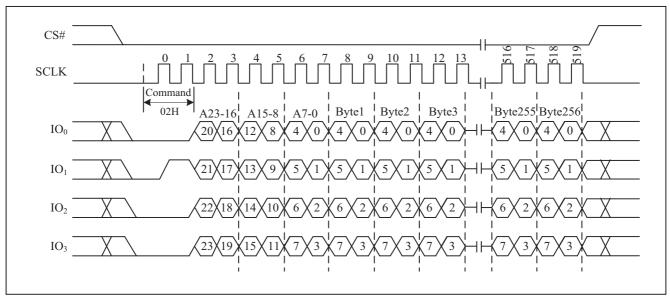
Figure16. Page Program Sequence Diagram





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Figure16a. Page Program Sequence Diagram (QPI)





1.8V Uniform Sector Dual and Quad Serial Flash 7.17. Quad Page Program (32H)

The Quad Page Program command is for programming the memory using four pins: IO0, IO1, IO2, and IO3. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Page Program command. The quad Page Program command is entered by driving CS# Low, followed by the command code (32H), three or four address bytes and at least one data byte on IO pins.

The command sequence is shown in Figure17. If more than 256 bytes are sent to the device, previously latched data are discarded and the last 256 data bytes are guaranteed to be programmed correctly within the same page. If less than 256 data bytes are sent to device, they are correctly programmed at the requested addresses without having any effects on the other bytes of the same page. CS# must be driven high after the eighth bit of the last data byte has been latched in; otherwise the Quad Page Program (PP) command is not executed.

As soon as CS# is driven high, the self-timed Quad Page Program cycle (whose duration is t_{PP}) is initiated. While the Quad Page Program cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Quad Page Program cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset.

A Quad Page Program command applied to a page which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) is not executed.

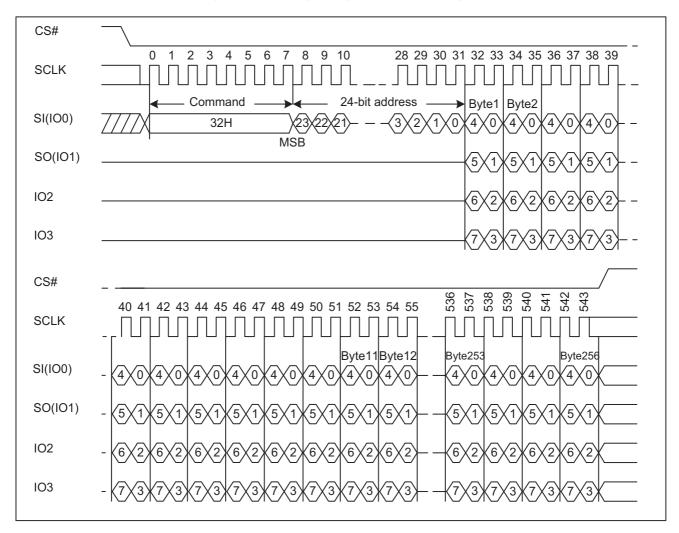


Figure17.Quad Page Program Sequence Diagram



1.8V Uniform SectorGigaDeviceDual and Quad Serial Flash7.18. Sector Erase (SE) (20H)

The Sector Erase (SE) command is erased the all data of the chosen sector. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit. The Sector Erase (SE) command is entered by driving CS# low, followed by the command code, and 3- byte address or 4-byte address on SI. Any address inside the sector is a valid address for the Sector Erase (SE) command. CS# must be driven low for the entire duration of the sequence.

The Sector Erase command sequence: CS# goes low \rightarrow sending Sector Erase command \rightarrow 3-byte address or 4-byte address on SI \rightarrow CS# goes high. The command sequence is shown in Figure18. CS# must be driven high after the eighth bit of the last address byte has been latched in; otherwise the Sector Erase (SE) command is not executed. As soon as CS# is driven high, the self-timed Sector Erase cycle (whose duration is t_{SE}) is initiated. While the Sector Erase cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Sector Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. A Sector Erase (SE) command applied to a sector which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) bit (see Table1&1a) is not executed.

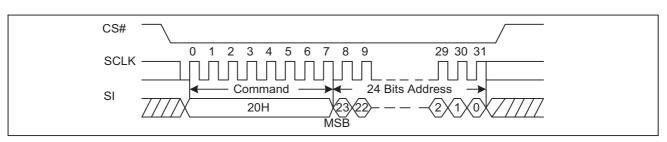


Figure 18. Sector Erase Sequence Diagram

Note: The device default is in 24-bit address mode. For 4-byte mode, the address length becomes 32-bit.

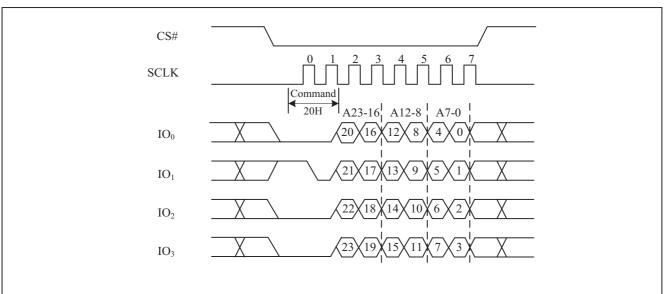


Figure18a. Sector Erase Sequence Diagram (QPI)



1.8V Uniform Sector Dual and Quad Serial Flash 7.19. 32KB Block Erase (BE) (52H)

The 32KB Block Erase (BE) command is erased the all data of the chosen block. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit. The 32KB Block Erase (BE) command is entered by driving CS# low, followed by the command code, and 3-byte address or 4-byte address on SI. Any address inside the block is a valid address for the 32KB Block Erase (BE) command. CS# must be driven low for the entire duration of the sequence.

The 32KB Block Erase command sequence: CS# goes low \rightarrow sending 32KB Block Erase command \rightarrow 3-byte address or 4-byte address on SI \rightarrow CS# goes high. The command sequence is shown in Figure19. CS# must be driven high after the eighth bit of the last address byte has been latched in; otherwise the 32KB Block Erase (BE) command is not executed. As soon as CS# is driven high, the self-timed Block Erase cycle (whose duration is t_{SE}) is initiated. While the Block Erase cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Block Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. A 32KB Block Erase (BE) command applied to a block which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) bits (see Table1&1a) is not executed.

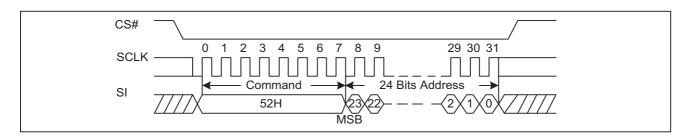


Figure 19. 32KB Block Erase Sequence Diagram

Note: The device default is in 24-bit address mode. For 4-byte mode, the address length becomes 32-bit.

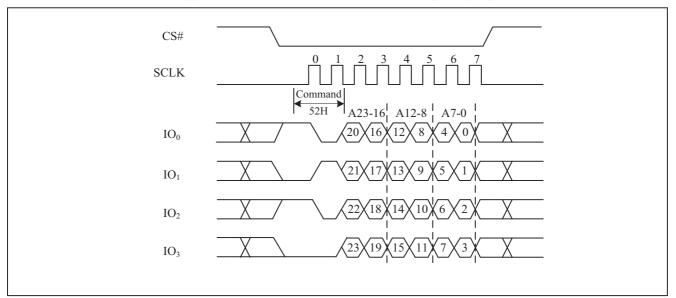
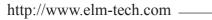


Figure19a. 32KB Block Erase Sequence Diagram (QPI)





1.8V Uniform Sector Dual and Quad Serial Flash 7.20. 64KB Block Erase (BE) (D8H)

The 64KB Block Erase (BE) command is erased the all data of the chosen block. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit. The 64KB Block Erase (BE) command is entered by driving CS# low, followed by the command code, and 3-byte address or 4-byte address on SI. Any address inside the block is a valid address for the 64KB Block Erase (BE) command. CS# must be driven low for the entire duration of the sequence.

The 64KB Block Erase command sequence: CS# goes low \rightarrow sending 64KB Block Erase command \rightarrow 3-byte address or 4-byte address on SI \rightarrow CS# goes high. The command sequence is shown in Figure20. CS# must be driven high after the eighth bit of the last address byte has been latched in; otherwise the 64KB Block Erase (BE) command is not executed. As soon as CS# is driven high, the self-timed Block Erase cycle (whose duration is t_{SE}) is initiated. While the Block Erase cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Block Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. A 64KB Block Erase (BE) command applied to a block which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) bits (see Table1&1a) is not executed.

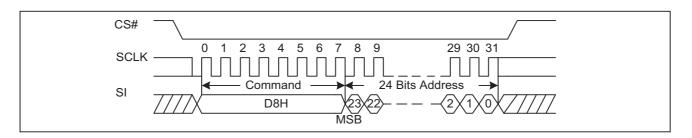
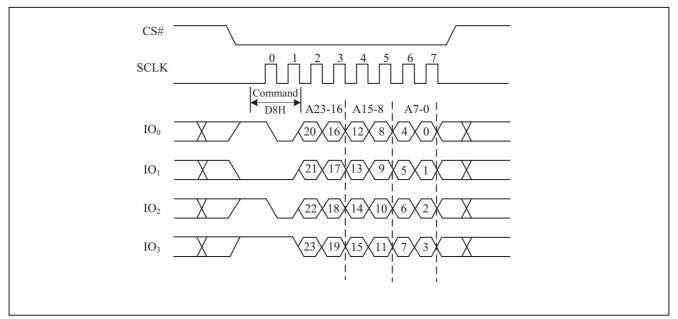


Figure 20. 64KB Block Erase Sequence Diagram

Note: The device default is in 24-bit address mode. For 4-byte mode, the address length becomes 32-bit.



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Figure20a. 64KB Block Erase Sequence Diagram (QPI)



1.8V Uniform Sector <u>GigaDevice</u> Dual and Quad Serial Flash 7.21. Chip Erase (CE) (60/C7H)

The Chip Erase (CE) command is erased the all data of the chip. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit .The Chip Erase (CE) command is entered by driving CS# Low, followed by the command code on Serial Data Input (SI). CS# must be driven Low for the entire duration of the sequence.

The Chip Erase command sequence: CS# goes low \rightarrow sending Chip Erase command \rightarrow CS# goes high. The command sequence is shown in Figure21. CS# must be driven high after the eighth bit of the command code has been latched in; otherwise the Chip Erase command is not executed. As soon as CS# is driven high, the self-timed Chip Erase cycle (whose duration is t_{CE}) is initiated. While the Chip Erase cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Chip Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. The Chip Erase (CE) command is executed if the Block Protect (BP2, BP1, and BP0) bits are 1 and CMP=1. The Chip Erase (CE) command is ignored if one or more sectors are protected.

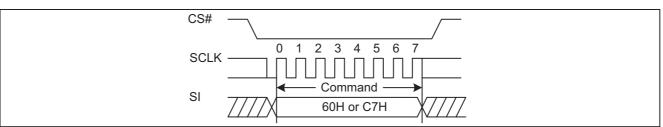
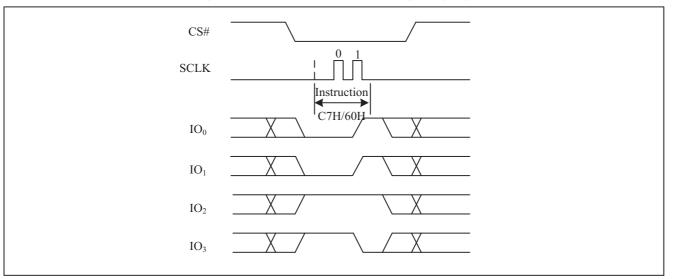


Figure21. Chip Erase Sequence Diagram







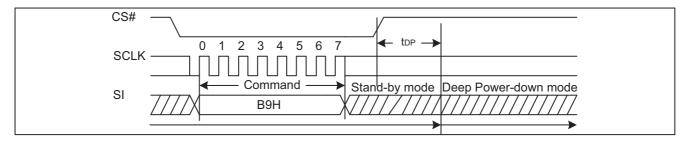
1.8V Uniform Sector GigaDevice Dual and Quad Serial Flash 7.22. Deep Power-Down (DP) (B9H)

Executing the Deep Power-Down (DP) command is the only way to put the device in the lowest consumption mode (the Deep Power-Down Mode). It can also be used as an extra software protection mechanism, while the device is not in active use, since in this mode, the device ignores all Write, Program and Erase commands. Driving CS# high deselects the device, and puts the device in the Standby Mode (if there is no internal cycle currently in progress). But this mode is not the Deep Power-Down Mode. The Deep Power-Down Mode can only be entered by executing the Deep Power-Down (DP) command. Once the device has entered the Deep Power-Down Mode, all commands are ignored except the Release from Deep Power-Down and Read Device ID (RDI) (ABH) or Enable Reset (66H) and Reset (99H) commands. These commands can release the device from this mode. The Release from Deep Power-Down and Read Device ID (RDI) command releases the device from deep power down mode , also allows the Device ID of the device to be output on SO.

The Deep Power-Down Mode automatically stops at Power-Down, and the device is in the Standby Mode after Power-Up.

The Deep Power-Down command sequence: CS# goes low \rightarrow sending Deep Power-Down command \rightarrow CS# goes high. The command sequence is shown in Figure22. CS# must be driven high after the eighth bit of the command code has been latched in; otherwise the Deep Power-Down (DP) command is not executed. As soon as CS# is driven high, it requires a delay of tDP before the supply current is reduced to ICC2 and the Deep Power-Down Mode is entered. Any Deep Power-Down (DP) command, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.





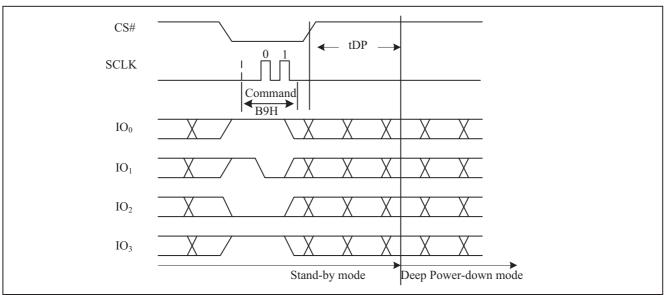


Figure22a. Deep Power-Down Sequence Diagram (QPI)



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7.23. Release from Deep Power-Down and Read Device ID (RDI) (ABH)

The Release from Power-Down and Read Device ID command is a multi-purpose command. It can be used to release the device from the Power-Down state or obtain the devices electronic identification (ID) number.

To release the device from the Power-Down state, the command is issued by driving the CS# pin low, shifting the instruction code "ABH" and driving CS# high as shown in Figure23. Release from Power-Down will take the time duration of t_{RES1} (See AC Characteristics) before the device will resume normal operation and other command are accepted. The CS# pin must remain high during the t_{RES1} time duration.

When used only to obtain the Device ID while not in the Power-Down state, the command is initiated by driving the CS# pin low and shifting the instruction code "ABH" followed by 3-dummy byte. The Device ID bits are then shifted out on the falling edge of SCLK with most significant bit (MSB) first as shown in Figure23. The Device ID value for the GD25LB256D is listed in Manufacturer and Device Identification table. The Device ID can be read continuously. The command is completed by driving CS# high.

When used to release the device from the Power-Down state and obtain the Device ID, the command is the same as previously described, and shown in Figure24, except that after CS# is driven high it must remain high for a time duration of t_{RES2} (See AC Characteristics). After this time duration the device will resume normal operation and other command will be accepted. If the Release from Power-Down / Device ID command is issued while an Erase, Program or Write cycle is in process (when WIP equal 1) the command is ignored and will not have any effects on the current cycle. **Figure23. Release Power-Down Sequence Diagram**

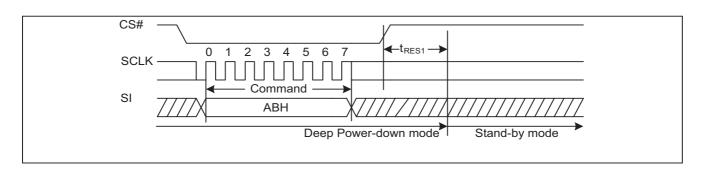
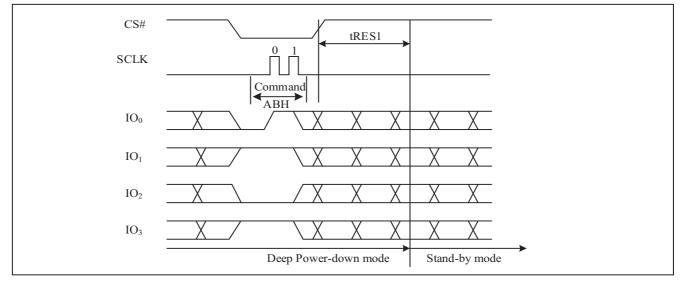


Figure23a. Release Power-Down Sequence Diagram (QPI)



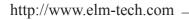
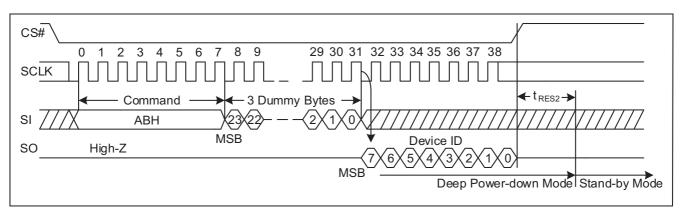
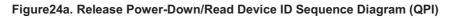


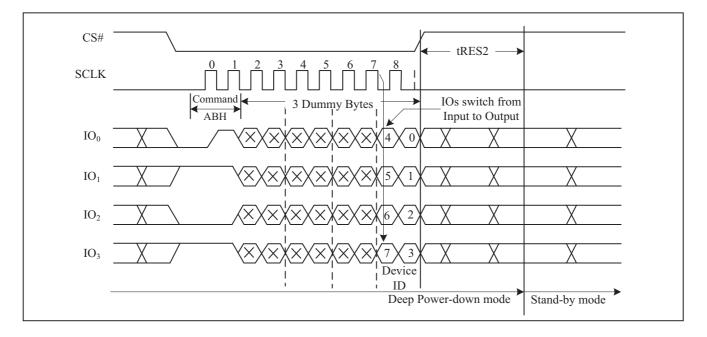




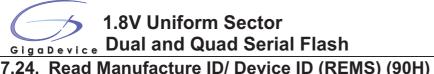
Figure24. Release Power-Down/Read Device ID Sequence Diagram







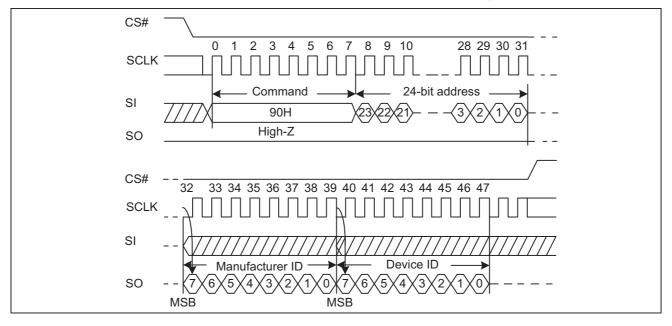




7.24. Read Manufacture ID/ Device ID (REMS) (90H)

The Read Manufacturer/Device ID command is an alternative to the Release from Power-Down / Device ID command that provides both the JEDEC assigned Manufacturer ID and the specific Device ID.

The command is initiated by driving the CS# pin low and shifting the command code "90H" followed by a 24-bit address (A23-A0) of 000000H. After which, the Manufacturer ID and the Device ID are shifted out on the falling edge of SCLK with most significant bit (MSB) first as shown in Figure 25. If the 24-bit address is initially set to 000001H, the Device ID will be read first.



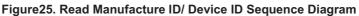
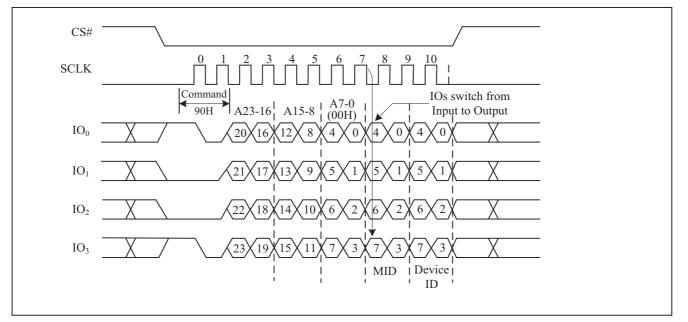


Figure25a. Read Manufacture ID/ Device ID Sequence Diagram (QPI)







The Read Manufacturer/Device ID Dual I/O command is an alternative to the Release from Power-Down / Device ID command that provides both the JEDEC assigned Manufacturer ID and the specific Device ID by dual I/O.

The command is initiated by driving the CS# pin low and shifting the command code "92H" followed by a 24-bit address (A23-A0) of 000000H. After which, the Manufacturer ID and the Device ID are shifted out on the falling edge of SCLK with most significant bit (MSB) first as shown in Figure 26. If the 24-bit address is initially set to 000001H, the Device ID will be read first.

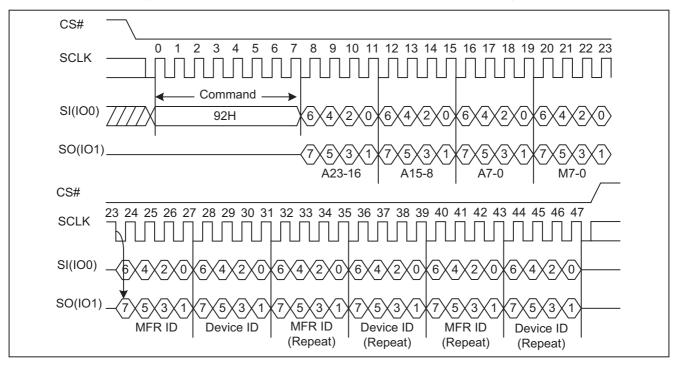
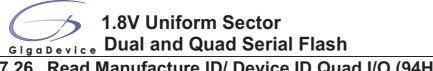


Figure26. Read Manufacture ID/ Device ID Dual I/O Sequence Diagram





7.26. Read Manufacture ID/ Device ID Quad I/O (94H)

The Read Manufacturer/Device ID Quad I/O command is an alternative to the Release from Power-Down / Device ID command that provides both the JEDEC assigned Manufacturer ID and the specific Device ID by quad I/O.

The command is initiated by driving the CS# pin low and shifting the command code "94H" followed by a 24-bit address (A23-A0) of 000000H. After which, the Manufacturer ID and the Device ID are shifted out on the falling edge of SCLK with most significant bit (MSB) first as shown in Figure 27. If the 24-bit address is initially set to 000001H, the Device ID will be read first.

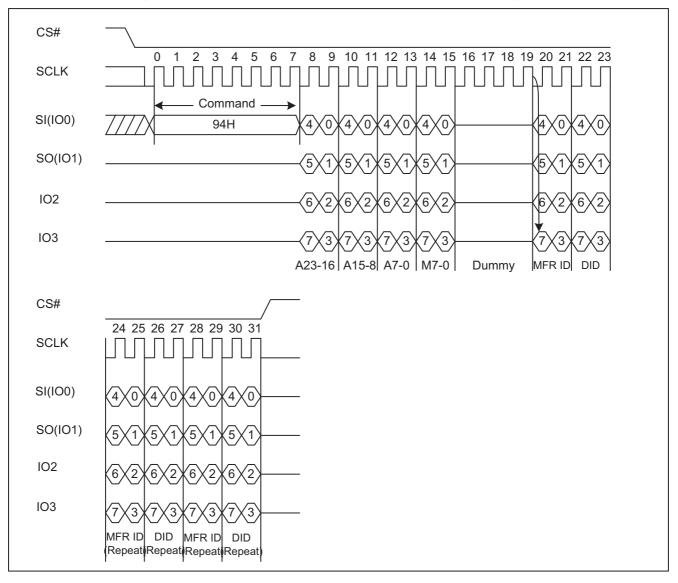


Figure27. Read Manufacture ID/ Device ID Quad I/O Sequence Diagram



1.8V Uniform Sector GigaDevice Dual and Quad Serial Flash 7.27. Read Identification (RDID) (9FH)

The Read Identification (RDID) command allows the 8-bit manufacturer identification to be read, followed by two bytes of device identification. The device identification indicates the memory type in the first byte, and the memory capacity of the device in the second byte. The Read Identification (RDID) command while an Erase or Program cycle is in progress, is not decoded, and has no effect on the cycle that is in progress. The Read Identification (RDID) command should not be issued while the device is in Deep Power-Down Mode.

The device is first selected by driving CS# to low. Then, the 8-bit command code for the command is shifted in. This is followed by the 24-bit device identification, stored in the memory. Each bit is shifted out on the falling edge of Serial Clock. The command sequence is shown in Figure 28. The Read Identification (RDID) command is terminated by driving CS# high at any time during data output. When CS# is driven high, the device is in the Standby Mode. Once in the Standby Mode, the device waits to be selected, so that it can receive, decode and execute commands.

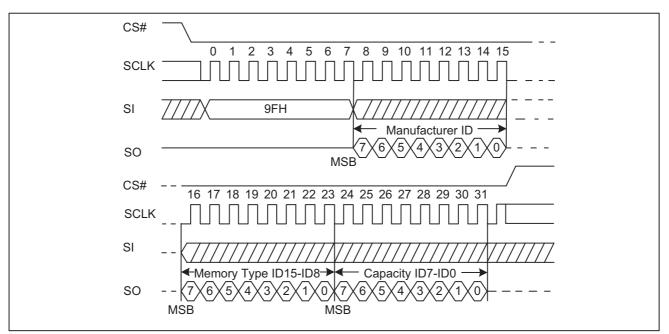
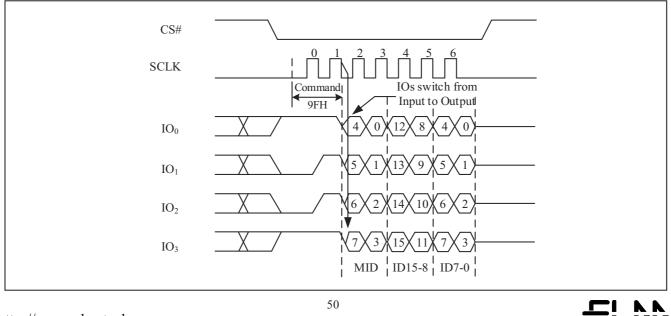


Figure28. Read Identification ID Sequence Diagram

Figure29a. Read Identification ID Sequence Diagram (QPI)



1.8V Uniform SectorGigaDeviceDual and Quad Serial Flash7.28. Program/Erase Suspend (PES) (75H)

The Program/Erase Suspend command "75H", allows the system to interrupt a page program or sector/block erase operation and then read data from any other sector or block. The Write Status Register command (01H) and Erase/Program Security Registers command (44H, 42H) and Erase commands (20H, 52H, D8H, C7H, 60H) and Page Program command (02H, 32H) are not allowed during Program suspend. The Write Status Register command (01H) and Erase Security Registers command (44H) and Erase commands (20H, 52H, D8H, C7H, 60H) are not allowed during Erase suspend. Program/Erase Suspend is valid only during the page program or sector/block erase operation. A maximum of time of "tsus" (See AC Characteristics) is required to suspend the program/erase operation.

The Program/Erase Suspend command will be accepted by the device only if the SUS2/SUS1 bit in the Status Register equal to 0 and WIP bit equal to 1 while a Page Program or a Sector or Block Erase operation is on-going. If the SUS2/SUS1 bit equal to 1 or WIP bit equal to 0, the Suspend command will be ignored by the device. The WIP bit will be cleared from 1 to 0 within "tsus" and the SUS2/SUS1 bit will be set from 0 to 1 immediately after Program/Erase Suspend. A power-off during the suspend period will reset the device and release the suspend state. The command sequence is show in Figure 29.

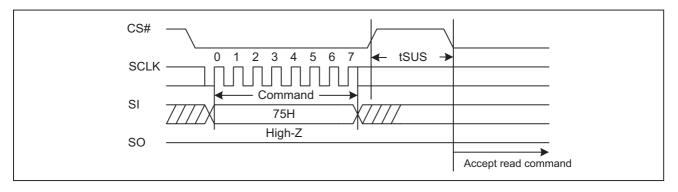
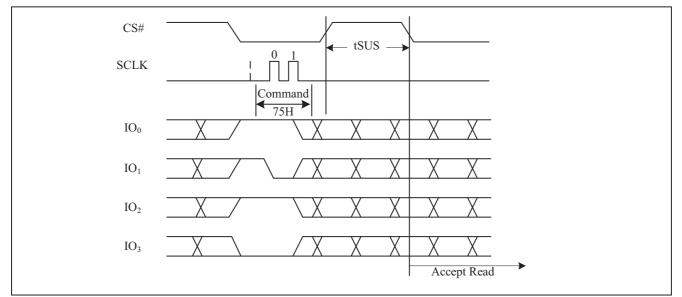
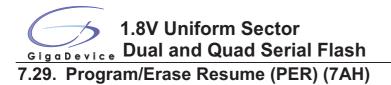


Figure 29. Program/Erase Suspend Sequence Diagram

Figure29a. Program/Erase Suspend Sequence Diagram (QPI)

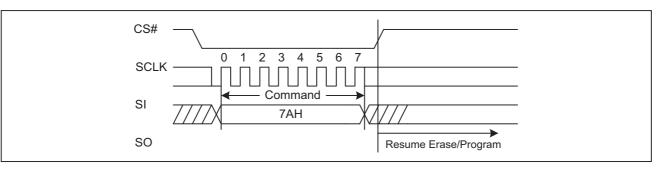


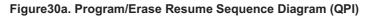


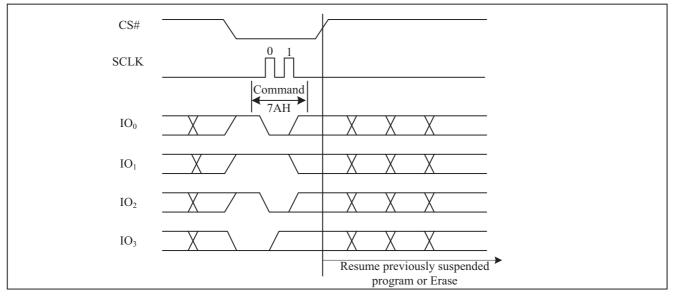


The Program/Erase Resume command must be written to resume the program or sector/block erase operation after a Program/Erase Suspend command. The Program/Erase Resume command will be accepted by the device only if the SUS2/SUS1 bit equal to 1 and the WIP bit equal to 0. After issued the SUS2/SUS1 bit in the status register will be cleared from 1 to 0 immediately, the WIP bit will be set from 0 to 1 within 200ns and the Sector or Block will complete the erase operation or the page will complete the program operation. The Program/Erase Resume command will be ignored unless a Program/Erase Suspend is active. The command sequence is show in Figure30.

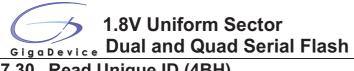








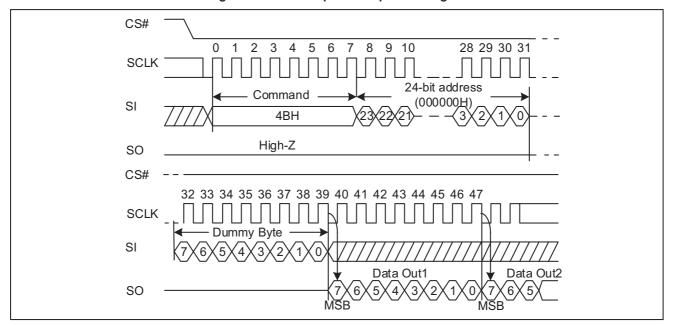


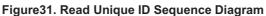


7.30. Read Unique ID (4BH)

The Read Unique ID command accesses a factory-set read-only 128bit number that is unique to each device. The Unique ID can be used in conjunction with user software methods to help prevent copying or cloning of a system.

The Read Unique ID command sequence: CS# goes low → sending Read Unique ID command → 3-Byte Address $(000000H) \rightarrow Dummy Byte \rightarrow 128bit Unique ID Out \rightarrow CS# goes high.$







1.8V Uniform Sector Dual and Quad Serial Flash 7.31. Erase Security Registers (44H)

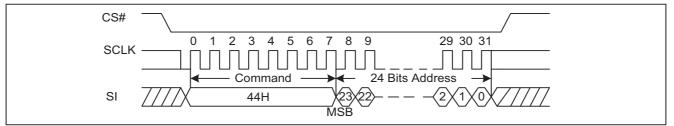
The GD25LB256D provides two 1024-byte Security Registers which can be erased and programmed individually. These registers may be used by the system manufacturers to store security and other important information separately from the main memory array.

The Erase Security Registers command is similar to Sector/Block Erase command. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit.

The Erase Security Registers command sequence: CS# goes low \rightarrow sending Erase Security Registers command \rightarrow 3-byte address on SI \rightarrow CS# goes high. The command sequence is shown in Figure32. CS# must be driven high after the eighth bit of the last address byte has been latched in; otherwise the Erase Security Registers command is not executed. As soon as CS# is driven high, the self-timed Erase Security Registers cycle (whose duration is t_{SE}) is initiated. While the Erase Security Registers cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Erase Security Registers cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. The Security Registers Lock Bit (LB2-3) in the Status Register can be used to OTP protect the security registers. Once the LB bit is set to 1, the Security Registers will be permanently locked; the Erase Security Registers command will be ignored.

Address	A23-16	A15-12	A11-10	A9-0
Security Register #2	00H	0010	0 0	Don't care
Security Register #3	00H	0011	0 0	Don't care







1.8V Uniform Sector Dual and Quad Serial Flash 7.32. Program Security Registers (42H)

The Program Security Registers command is similar to the Page Program command. Each security register contains four pages content. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Program Security Registers command. The Program Security Registers command is entered by driving CS# Low, followed by the command code (42H), three address bytes and at least one data byte on SI. As soon as CS# is driven high, the self-timed Program Security Registers cycle (whose duration is t_{PP}) is initiated. While the Program Security Registers cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Program Security Registers cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset.

If the Security Registers Lock Bit (LB2-3) is set to 1, the Security Registers will be permanently locked. Program Security Registers command will be ignored.

Address	A23-16	A15-12	A11-10	A9-0
Security Register #2	00H	0010	0 0	Byte Address
Security Register #3	00H	0011	0 0	Byte Address

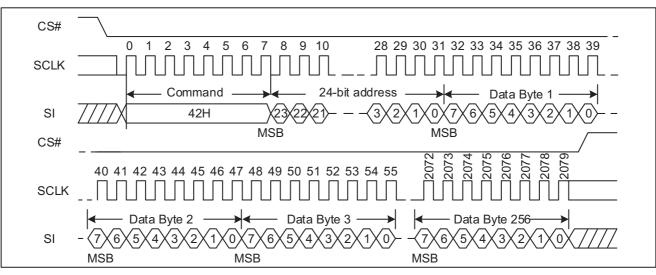


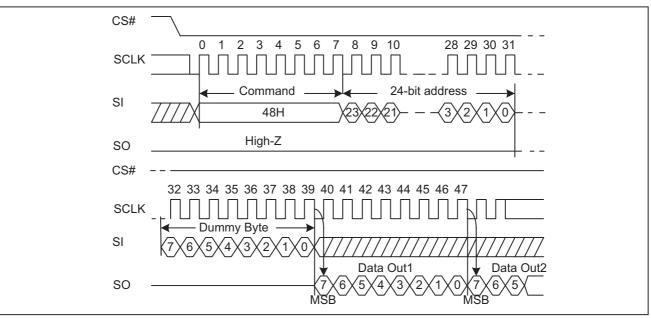
Figure33. Program Security Registers command Sequence Diagram





The Read Security Registers command is similar to Fast Read command. The command is followed by a 3-byte address (A23-A0) and a dummy byte, and each bit is latched-in on the rising edge of SCLK. Then the memory content, at that address, is shifted out on SO, and each bit is shifted out, at a Max frequency f_C, on the falling edge of SCLK. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. Once the A9-A0 address reaches the last byte of the register (Byte 3FFH), it will reset to 000H, the command is completed by driving CS# high.

	0 0			
Address	A23-16	A15-12	A11-10	A9-0
Security Register #2	00H	0010	0 0	Byte Address
Security Register #3	00H	0011	0 0	Byte Address









7.34. Set Read Parameters (C0H)

In QPI mode the "Set Read Parameters (C0H)" command can be used to configure the number of dummy clocks for "Fast Read (0BH)", "Quad I/O Fast Read (EBH)", "Burst Read with Wrap (0CH)", "Burst Read with Wrap for Lower 128Mb (8CH)" and "Burst Read with Wrap For Higher 128Mb (8DH)" command, and to configure the number of bytes of "Wrap Length" for the "Burst Read with Wrap (0CH)" command. The "Wrap Length" is set by W5-6 bit in the "Set Burst with Wrap (77H)" command. This setting will remain unchanged when the device is switched from Standard SPI mode to QPI mode.

P5-P4	Dummy Clocks	Maximum Read Freq.	P1-P0	Wrap Length
0 0	4	80MHz	0 0	8-byte
0 1	6	108MHz	0 1	16-byte
1 0	8	120MHz	10	32-byte
11	8	120MHz	11	64-byte

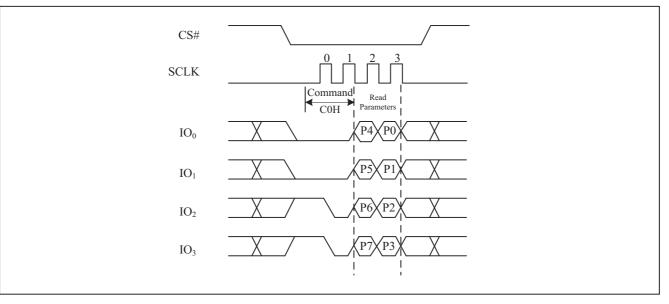
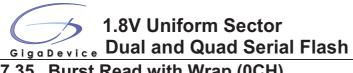
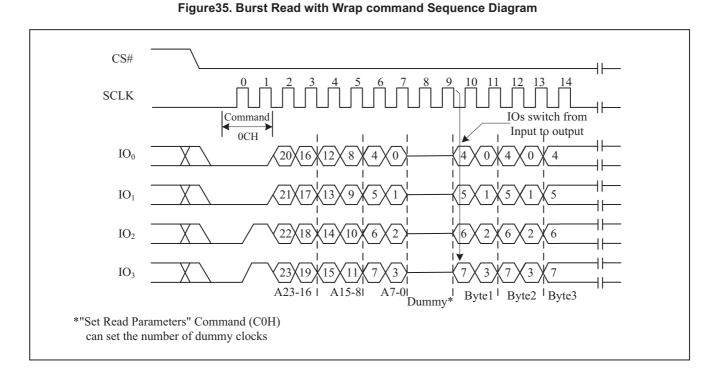


Figure 34. Set Read Parameters command Sequence Diagram



7.35. Burst Read with Wrap (0CH)

The "Burst Read with Wrap (0CH)" command provides an alternative way to perform the read operation with "Wrap Around" in QPI mode. This command is similar to the "Fast Read (0BH)" command in QPI mode, except the addressing of the read operation will "Wrap Around" to the beginning boundary of the "Wrap Around" once the ending boundary is reached. The "Wrap Length" and the number of dummy clocks can be configured by the "Set Read Parameters (C0H)" command.







1.8V Uniform SectorGigaDeviceDual and Quad Serial Flash7.36. Burst Read with Wrap for Lower 128Mb (8CH)

The "Burst Read with Wrap for Lower 128Mb (8CH)" command provides an alternative way to perform the read operation with "Wrap Around" in QPI mode. This command is similar to the "Fast Read (0BH)" command in QPI mode, except the addressing of the read operation will "Wrap Around" to the beginning boundary of the "Wrap Around" once the ending boundary is reached. The "Wrap Length" and the number of dummy clocks can be configured by the "Set Read Parameters (C0H)" command. The "Burst Read with Wrap for Lower 128Mb (8CH)" command will read out the memory content from 000000H to 0FFFFFH.

The "Burst Read with Wrap for Lower 128Mb (8CH)" command sequence: CS# goes low \rightarrow sending The "Burst Read with Wrap for Lower 128Mb (8CH)" command \rightarrow sending 3-byte address (A23-A0, The A24 default value is 0) \rightarrow sending dummy byte \rightarrow then data out.

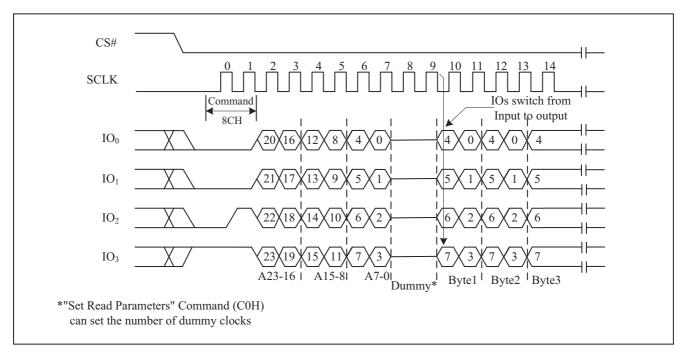


Figure 36. Burst Read with Wrap for Lower 128Mb command Sequence Diagram



I.8V Uniform SectorGigaDeviceDual and Quad Serial Flash7.37. Burst Read with Wrap for Higher 128Mb (8DH)

The "Burst Read with Wrap for Higher 128Mb (8DH)" command provides an alternative way to perform the read operation with "Wrap Around" in QPI mode. This command is similar to the "Fast Read (0BH)" command in QPI mode, except the addressing of the read operation will "Wrap Around" to the beginning boundary of the "Wrap Around" once the ending boundary is reached. The "Wrap Length" and the number of dummy clocks can be configured by the "Set Read Parameters (C0H)" command. The "Burst Read with Wrap for higher 128Mb (8DH)" command will read out the memory content from 1000000H to 1FFFFFH.

The "Burst Read with Wrap for Higher 128Mb (8DH)" command sequence: CS# goes low \rightarrow sending The "Burst Read with Wrap for Higher 128Mb (8DH)" command \rightarrow sending 3-byte address (A23-A0, The A24 default value is 1) \rightarrow sending dummy byte \rightarrow then data out.

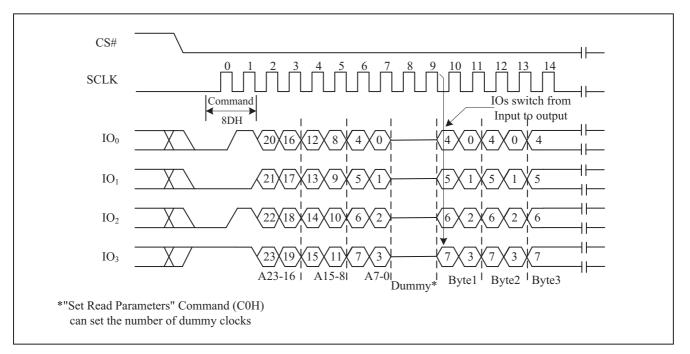
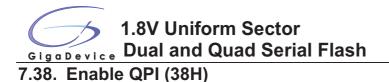


Figure 37. Burst Read with Wrap for Higher 128Mb command Sequence Diagram





The device support both Standard/Dual/Quad SPI and QPI mode. The "Enable QPI (38H)" command can switch the device from SPI mode to QPI mode. See the command Table 2a for all support QPI commands. When the device is switched from SPI mode to QPI mode, the existing Write Enable Latch and Program/Erase Suspend status, and the Wrap Length setting will remain unchanged.

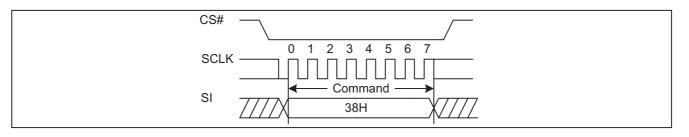
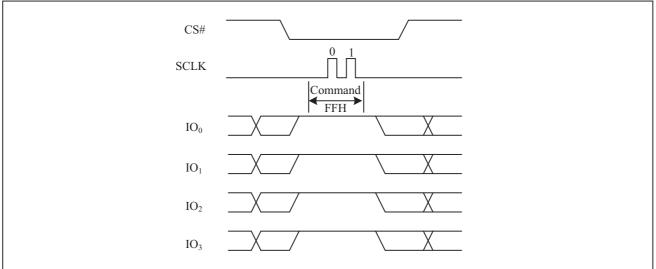


Figure 38. Enable QPI mode command Sequence Diagram

7.39. Disable QPI (FFH)

To exit the QPI mode and return to Standard/Dual/Quad SPI mode, the "Disable QPI (FFH)" command must be issued. When the device is switched from QPI mode to SPI mode, the existing Write Enable Latch and Program/Erase Suspend status, and the Wrap Length setting will remain unchanged.







1.8V Uniform SectorGigaDeviceDual and Quad Serial Flash7.40. Enable Reset (66H) and Reset (99H)

If the Reset command is accepted, any on-going internal operation will be terminated and the device will return to its default power-on state and lose all the current volatile settings, such as Volatile Status Register bits, Write Enable Latch status (WEL), Program/Erase Suspend status, Read Parameter setting (P7-P0), Continuous Read Mode bit setting (M7-M0) and Wrap Bit Setting (W6-W4).

The "Enable Reset (66H)" and the "Reset (99H)" commands can be issued in either SPI or QPI mode. The "Reset (99H)" command sequence as follow: CS# goes low \rightarrow Sending Enable Reset command \rightarrow CS# goes high \rightarrow CS# goes low \rightarrow Sending Reset command \rightarrow CS# goes high. Once the Reset command is accepted by the device, the device will take approximately t_{RST} /t_{RST_E} to reset. During this period, no command will be accepted. Data corruption may happen if there is an on-going or suspended internal Erase or Program operation when Reset command sequence is accepted by the device. It is recommended to check the BUSY bit and the SUS bit in Status Register before issuing the Reset command sequence.

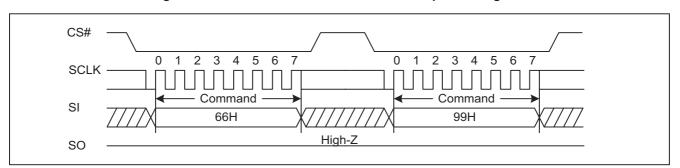
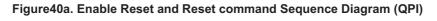
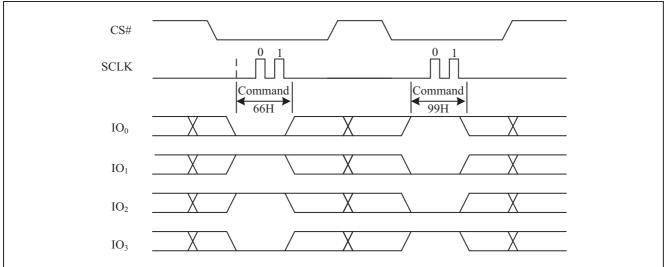
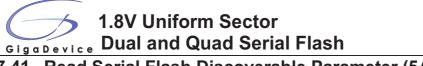


Figure40. Enable Reset and Reset command Sequence Diagram







7.41. Read Serial Flash Discoverable Parameter (5AH)

The Serial Flash Discoverable Parameter (SFDP) standard provides a consistent method of describing the functional and feature capabilities of serial flash devices in a standard set of internal parameter tables. These parameter tables can be interrogated by host system software to enable adjustments needed to accommodate divergent features from multiple vendors. The concept is similar to the one found in the Introduction of JEDEC Standard, JESD68 on CFI. SFDP is a standard of JEDEC Standard No.216.

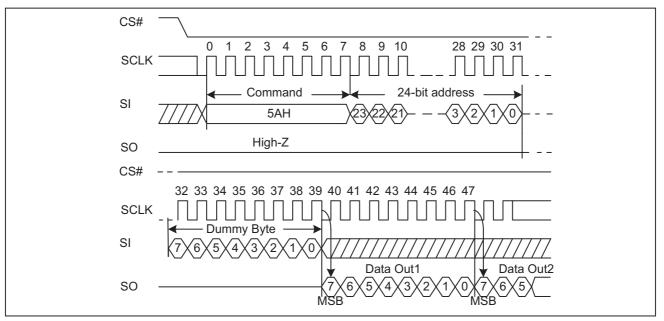
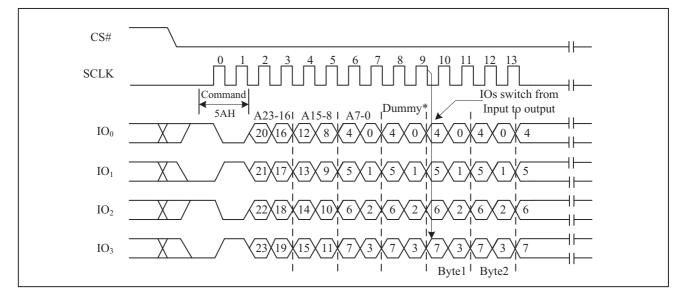




Figure41a. Read Serial Flash Discoverable Parameter command Sequence Diagram (QPI)





1.8V Uniform Sector GigaDevice Dual and Quad Serial Flash

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Table3. Signature and Parameter Identification Data Values

Table3. Signature and Parameter Identification Data Values							
Description	Comment	Add(H)	DW Add	Data	Data		
		(Byte)	(Bit)				
SFDP Signature	Fixed:50444653H	00H	07:00	53H	53H		
		01H	15:08	46H	46H		
		02H	23:16	44H	44H		
		03H	31:24	50H	50H		
SFDP Minor Revision Number	Start from 00H	04H	07:00	00H	00H		
SFDP Major Revision Number	Start from 01H	05H	15:08	01H	01H		
Number of Parameters Headers	Start from 00H	06H	23:16	01H	01H		
Unused	Contains 0xFFH and can never	07H	31:24	FFH	FFH		
	be changed						
ID number (JEDEC)	00H: It indicates a JEDEC	08H	07:00	00H	00H		
	specified header						
Parameter Table Minor Revision	Start from 0x00H	09H	15:08	00H	00H		
Number							
Parameter Table Major Revision	Start from 0x01H	0AH	23:16	01H	01H		
Number							
Parameter Table Length	How many DWORDs in the	0BH	31:24	09H	09H		
(in double word)	Parameter table						
Parameter Table Pointer (PTP)	First address of JEDEC Flash	0CH	07:00	30H	30H		
	Parameter table	0DH	15:08	00H	00H		
		0EH	23:16	00H	00H		
Unused	Contains 0xFFH and can never	0FH	31:24	FFH	FFH		
	be changed						
ID Number LSB	It is indicates GigaDevice	10H	07:00	C8H	C8H		
(GigaDevice Manufacturer ID)	manufacturer ID						
Parameter Table Minor Revision	Start from 0x00H	11H	15:08	00H	00H		
Number							
Parameter Table Major Revision	Start from 0x01H	12H	23:16	01H	01H		
Number							
Parameter Table Length	How many DWORDs in the	13H	31:24	03H	03H		
(in double word)	Parameter table						
Parameter Table Pointer (PTP)	First address of GigaDevice Flash	14H	07:00	60H	60H		
	Parameter table	15H	15:08	00H	00H		
		16H	23:16	00H	00H		
Unused	Contains 0xFFH and can never	17H	31:24	FFH	FFH		
	be changed						





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Table4. Parameter Table (0): JEDEC Flash Parameter Tables

Description	Comment	Add(H)	DW Add	Data	Data
		(Byte)	(Bit)		
	00: Reserved; 01: 4KB erase;				
Block/Sector Erase Size	10: Reserved;		01:00	01b	
	11: not support 4KB erase				
Write Granularity	0: 1Byte, 1: 64Byte or larger		02	1b	
Write Enable Instruction	0: Nonvolatile status bit				
Requested for Writing to Volatile	1: Volatile status bit		03	0b	
Status Registers	(BP status register bit)	30H			E5H
	0: Use 50H Opcode,	5011			
Write Enable Opcode Select for	1: Use 06H Opcode,				
Writing to Volatile Status	Note: If target flash status register		04	0b	
Registers	is Nonvolatile, then bits 3 and 4				
	must be set to 00b.				
	Contains 111b and can never be		07.05	4446	
Unused	changed		07:05	111b	
4KB Erase Opcode		31H	15:08	20H	20H
(1-1-2) Fast Read	0=Not support, 1=Support		16	1b	
Address Bytes Number used in	00: 3Byte only, 01: 3 or 4Byte,]	10.17	016	
addressing flash array	10: 4Byte only, 11: Reserved		18:17	01b	
Double Transfer Rate (DTR)			10	Oh	
clocking	0=Not support, 1=Support	32H	19	0b	F3H
(1-2-2) Fast Read	0=Not support, 1=Support		20	1b	
(1-4-4) Fast Read	0=Not support, 1=Support		21	1b	
(1-1-4) Fast Read	0=Not support, 1=Support		22	1b	
Unused			23	1b	
Unused		33H	31:24	FFH	FFH
Flash Memory Density		37H:34H	31:00	0FFFF	FFH
(1-4-4) Fast Read Number of	0 0000b: Wait states (Dummy				
Wait states	Clocks) not support		04:00	00100b	
(1-4-4) Fast Read Number of		38H			44H
Mode Bits	000b:Mode Bits not support		07:05	010b	
(1-4-4) Fast Read Opcode		39H	15:08	EBH	EBH
(1-1-4) Fast Read Number of	0 0000b: Wait states (Dummy				
Wait states	Clocks) not support		20:16	01000b	
(1-1-4) Fast Read Number of		3AH			08H
Mode Bits	000b:Mode Bits not support		23:21	000b	
(1-1-4) Fast Read Opcode		ЗВН	31:24	6BH	6BH
(1-1-2) Fast Read Number of	0 0000b: Wait states (Dummy				
Wait states	Clocks) not support		04:00	01000b	
(1-1-2) Fast Read Number		3CH			08H
of Mode Bits	000b: Mode Bits not support		07:05	000b	





1.8V Uniform Sector Dual and Quad Serial Flash

GD25LB256D

(1-2) Fast Read Opcode0000b: Wait states (Dummy Clocks) not support3DH15:083BH3BH(1-2:) Fast Read Number of Mode Bits000b: Mode Bits not support3EH3EH001:003EH(1-2:) Fast Read Opcode0:00: Mode Bits not support3FH3I:24BBHBBH(2-2:) Fast Read Opcode0:00 support1=support3FH3I:24BBHBBH(2-2:) Fast Read Opcode0:00 support1=support3FH3I:24BBHBBH(2-2:) Fast Read Opcode0:00 support1=support44H15:000.007EH(4-4.4) Fast Read Number Of Mode Bits0:000: Wait states (Dummy Clocks) not support45H:4415:000.XFFH0.YFFH(2-2:) Fast Read Number Of Mode Bits0:000: Wait states (Dummy Clocks) not support45H:4415:000.XFFH0.YFFH(2-2:) Fast Read Number Of Mode Bits0:000: Wait states (Dummy Clocks) not support45H:4415:000.XFFH0.YFFH(2-2:) Fast Read Number Of Mode Bits0:000: Wait states (Dummy Clocks) not support47H31:24FFH0.YFFH(4-4.4) Fast Read Number Of Mode Bits0:000: Wait states (Dummy Clocks) not support47HH31:240.XFFH0.YFFH(4-4.4) Fast Read Number Of Mode Bits0:000: Wait states (Dummy Clocks) not support47HH31:240.XFFH0.YFFH(4-4.4) Fast Read Number Of Mode Bits0:000: Wait states (Dummy Clocks) not support47HH31:240.XFFH0.YFFH(GigaDevice - otori ottori o					
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(1-2-2) Fast Read Number of Mode Bits 000b: Mode Bits not support 23:21 010b (1-2-2) Fast Read Opcode 0=not support 1=support 3FH 31:24 BBH BBH (2-2-2) Fast Read 0=not support 1=support 03:01 111b 03:01 111b (4-4.4) Fast Read 0=not support 1=support 40H 03:01 111b 7FH Unused 0=not support 1=support 43H:41H 31:08 0xFFH 0xFFH Unused 0=not support 1=support 45H:44H 15:00 0xFFH 0xFFH Unused 0 0000b: Wait states (Dummy clocks) not support 46H 15:00 0xFFH 0xFFH (2-2-2) Fast Read Number of Mode Bits 000b: Mode Bits not support 47H 31:24 FFH FFH Unused 000b: Mode Bits not support 49H:48H 15:00 0xFFH 0xFFH (4-4.4) Fast Read Number of Mode Bits 0 000b: Wait states (Dummy Clocks) not support 41H 112 FFH FFH (4-4.4) Fast Read Number of Mode Bits 000b: Mode Bits not support 42H:41	of Wait states	Clocks) not support	250	20.10	000100	400
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Sector Type 2 Size	Sector Type 1 erase Opcode		4DH	15:08	20H	20H
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Ox00b: this sector type don't exist Ox00b: this sector type don't exist Sector Type 3 erase Opcode 51H 15:08 D8H Sector Type 4 Size Sector/block size=2^N bytes 52H 23:16 00H 00H	Caster Turne 2 Cin-	Sector/block size=2^N bytes	5011	07-00	1011	1011
Sector/block size=2^N bytes 52H 23:16 00H 00H	Sector Type 3 Size	0x00b: this sector type don't exist	50H	07:00	10H	10H
Sector Type 4 Size 52H 23:16 00H 00H	Sector Type 3 erase Opcode		51H	15:08	D8H	D8H
0x00b: this sector type don't exist 52H 23:16 00H 00H	Caster Turne 4 Cint	Sector/block size=2^N bytes	5011	00-40	0011	0011
	Sector Type 4 Size	0x00b: this sector type don't exist	52H	23:16	UUH	00H
Sector Type 4 erase Opcode 53H 31:24 FFH FFH	Sector Type 4 erase Opcode		53H	31:24	FFH	FFH





1.8V Uniform Sector GigaDevice Dual and Quad Serial Flash

GD25LB256D

Table5. Parameter Table (1): GigaDevice Flash Parameter Tables

DescriptionCommentAdd(H) (B(H)DW Add (B(H)Data (B(Table5. Parameter Table (1): GigaDevice Flash Parameter Tables								
2000H=2.000V 3600H=3.600V 61H:60H 15:00 2000H 2000H Vcc Supply Minimum Voltage 1650H=1.650V 2250H=2.250V 2350H=2.250V 2350H=2.250V 63H:62H 31:16 1650H 1650H Vcc Supply Minimum Voltage 2250H=2.250V 2350H=2.250V 63H:62H 31:16 1650H 1650H Vcc Supply Minimum Voltage 0=not support 1=support 0 0 0 HW Reset# pin 0=not support 1=support 0 0 0 0 SW Reset 0=not support 1=support 0 0 0 0 0 SW Reset Opcode Should be issue Reset 65H:64H 11:04 99H F99CH Program Suspend/Resume 0=not support 1=support 12 1b 13 1b Unused 0=not support 1=support 13 1b 14 1b Wrap-Around Read mode 0=not support 66H 23:16 77H 77H Wrap-Around Read data length 16H:88A16BA32B 67H 31:24 64H 64	Description	Comment			Data	Data			
Vcc Supply Minimum Voltage 2250H=2.250V 230H=2.30V 2700H=2.700V 63H:62H 31:16 1650H HW Reset# pin 0=not support 1=support 0 0 0 HW Hold# pin 0=not support 1=support 0 0 0 Beep Power Down Mode 0=not support 1=support 0 0 0 0 SW Reset 0=not support 1=support 0 0 0 0 0 SW Reset 0=not support 1=support 0 0 0 0 0 SW Reset 0=not support 1=support 0 0 0 0 0 SW Reset 0=not support 1=support 0 0 0 0 0 Program Suspend/Resume 0=not support 1=support 11:04 99H 99H Unused 0=not support 1=support 14 1b 16 Wrap-Around Read mode 0=not support 1=support 66H 23:16 77H 7H Wrap-Around Read data length 16H:88&168 32H:88&168 32H:88&168 11:04 0 0 31:14 0 0 0 0 0 0 0 Individual block lock bit 0=not support 1=support 67H 31:24 64H 64H </td <td>Vcc Supply Maximum Voltage</td> <td>2700H=2.700V</td> <td>61H:60H</td> <td>15:00</td> <td>2000H</td> <td>2000H</td>	Vcc Supply Maximum Voltage	2700H=2.700V	61H:60H	15:00	2000H	2000H			
HW Hold# pin 0=not support 1=support 01 0b 02 1b 1b 03 1b 1b 03 1b	Vcc Supply Minimum Voltage	2250H=2.250V 2350H=2.350V	63H:62H	31:16	1650H	1650H			
HW Hold# pin 0=not support 1=support Deep Power Down Mode 0=not support 1=support SW Reset 0=not support 1=support SW Reset 0=not support 1=support SW Reset 0=not support 1=support SW Reset Opcode Enable(66H) before Reset cmd. 65H:64H 11:04 99H Program Suspend/Resume 0=not support 1=support 13 1b Unused 0=not support 1=support 14 1b Wrap-Around Read mode 0=not support 1=support 15 1b Wrap-Around Read mode 0=not support 1=support 66H 23:16 77H 77H Wrap-Around Read data length 08H:support 8B wrap-around read 16H:8B&16B 67H 31:24 64H 64H Individual block lock 0=not support 1=support 67H 31:24 64H 64H Individual block lock Not 0=volatile 1=Nonvolatile 67H 31:24 64H 64H Individual block lock Not 0=not support	HW Reset# pin	0=not support 1=support		00	0b				
SW Reset 0=not support 1=support SW Reset 0=not support 1=support 03 1b SW Reset Opcode Enable(66H) before Reset cmd. 65H:64H 11:04 99H F99CH Program Suspend/Resume 0=not support 1=support 11 14 1b Unused 0=not support 1=support 14 1b 15 1b Wrap-Around Read mode 0=not support 1=support 66H 23:16 77H 77H Wrap-Around Read mode 08H:support 8B wrap-around read 16H:88&16B 67H 31:24 64H 64H Wrap-Around Read data length 08H:support 1=support 67H 31:24 64H 64H Wrap-Around Read data length 0=not support 1=support 00 0b 01 0b Individual block lock 0=not support 1=support 6H:68 6H 6H:68 6H	· · ·		-	01	0b	-			
International base Interna			-	02	1b				
Should be issue Reset 5hould be issue Reset 65H:64H 11:04 99H F99CH SW Reset Opcode 0=not support 1=support 12 1b 13 1b Program Suspend/Resume 0=not support 1=support 13 1b 14 1b Unused 0=not support 1=support 66H 23:16 77H 77H Wrap-Around Read mode 0=not support 1=support 66H 23:16 77H 77H Wrap-Around Read mode 08H:support 8B wrap-around read 67H 31:24 64H 64H Mrap-Around Read data length 16H:s88.16B 32H:388.16B&32B.864B 67H 31:24 64H 64H Individual block lock 0=not support 1=support 67H 31:24 64H 64H Individual block lock bit 0=volatile 1=Nonvolatile 01 0b 0 0 Individual block lock Notalile 0=not support 1=support 68H:68 11 0b 0 0 Individual block lock Notalile 0=not support 1=support 13 1b 11			-	03	1b				
Individual block lock bit (Volatile/Nonvolatile) 0=not support 1=support 13 1b 14 1b 15 1b 16H:88&16B 32H:88&16B&32B 64H:88&16B&32B 66H 23:16 77H 77H 16H:88&16B 32H:88&16B&32B 64H 87H 31:24 64H 64H 16H:88&16B 32H:88&16B&32B 64H:88&16B 67H 31:24 64H 64H 1ndividual block lock lock 0=not support 1=support 67H 31:24 64H 64H 1ndividual block lock bit (Volatile/Nonvolatile) 0=volatile 1=Nonvolatile 01 0b 0b 1ndividual block lock Volatile protect bit default protect status 0=protect 1=unprotect 6H:68 10 0b H 111 1b 1b 12 0b H H 12 0b 13 1b 1b 15 11b	SW Reset Opcode	Enable(66H)	65H:64H	11:04	99H	F99CH			
$\begin{array}{ c c c c } \label{eq:constraint} Unused & I & I & I & I \\ \hline \begin{tabular}{ c c c c } & I & I & I & I \\ \hline \begin{tabular}{ c c c c c c } & I & I & I & I \\ \hline \begin{tabular}{ c c c c c c c c } & I & I & I & I \\ \hline \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	Program Suspend/Resume	0=not support 1=support		12	1b				
Wrap-Around Read mode $0=not support 1=support$ 151bWrap-Around Read mode Opcode $0=not support 1=support$ $66H$ $23:16$ $77H$ $77H$ Wrap-Around Read data length $08H:support 8B wrap-around read16H:8B&16B32H:8B&16B&32B64H:8B&16B&32B64H:8B&16B&32B&64B67H31:2464H64HIndividual block lock0=not support 1=support00b00b0Individual block lock bit(Volatile/Nonvolatile)0=volatile 1=Nonvolatile09:02FFH0b0Individual block lock Volatileprotect bit default protect status0=not support 1=support09:02FFH111bEBFCHRead Lock0=not support 1=support131b15:1411b15:1411bUnused0=not support 1=support15:1411b15:1411b$	Erase Suspend/Resume	0=not support 1=support	1	13	1b				
Wrap-Around OpcodeRead modeModeRead modeModeRead modeRead 	Unused]	14	1b				
Opcode66H23:1677H77HOpcode08H:support 8B wrap-around read 16H:8B&16B 32H:8B&16B&32B 64H:8B&16B&32B&64B67H31:2464H64HIndividual block lock0=not support 1=support67H31:2464H64HIndividual block lock bit (Volatile/Nonvolatile)0=volatile 1=Nonvolatile010b0Individual block lock Opcode0=protect 1=unprotect09:02FFH68H:6868H:6868H:6868H:6868H:68100b69:02FFH68H:6868H:6868H:68111bb15:1411b1bb </td <td>Wrap-Around Read mode</td> <td>0=not support 1=support</td> <td>]</td> <td>15</td> <td>1b</td> <td></td>	Wrap-Around Read mode	0=not support 1=support]	15	1b				
Wrap-Around Read data length16H:8B&16B 32H:8B&16B&32B 64H:8B&16B&32B&64B67H31:2464H64HIndividual block lock0=not support 1=support00bIndividual block lock bit (Volatile/Nonvolatile)0=Volatile 1=Nonvolatile010bIndividual block lock Volatile protect bit default protect status0=protect 1=unprotect09:02FFHEBFC HSecured OTP0=not support 1=support00b0bHRead Lock0=not support 1=support120b0b0b0b0bUnused0=not support 1=support131b1b0b0b0b			66H	23:16	77H	77H			
Individual block lock bit (Volatile/Nonvolatile)0=Volatile 1=Nonvolatile0010b0Individual block lock Opcode0=protect 1=unprotect09:02FFHIndividual block lock Volatile protect bit default protect status0=protect 1=unprotect6BH:68 H100bEBFC HSecured OTP0=not support 1=support111b120bRead Lock0=not support 1=support131b15:1411b	Wrap-Around Read data length	16H:8B&16B 32H:8B&16B&32B	67H	31:24	64H	64H			
(Volatile/Nonvolatile)0=Volatile1=Nonvolatile010bIndividual block lock Opcode0=protect	Individual block lock	0=not support 1=support		00	0b				
Individual block lock Volatile protect bit default protect status0=protect 1=unprotect6BH:68 H100bEBFC HSecured OTP0=not support 1=support111b111bRead Lock0=not support 1=support120b131bPermanent Lock0=not support 1=support15:1411b1b		0=Volatile 1=Nonvolatile		01	0b				
protect bit default protect status0=protect 1=unprotect6BH:68100bHSecured OTP0=not support 1=supportH111b120bRead Lock0=not support 1=support1=support120b131bPermanent Lock0=not support 1=support15:1411b15:1411b	Individual block lock Opcode			09:02	FFH				
Secured OTP0=not support1=supportRead Lock0=not support1=supportPermanent Lock0=not support1=supportUnused115:14		0=protect 1=unprotect		10	0b	_			
Permanent Lock 0=not support 13 1b Unused 15:14 11b	Secured OTP	0=not support 1=support	Н	11	1b				
Unused 15:14 11b	Read Lock	0=not support 1=support	1	12	0b				
	Permanent Lock	0=not support 1=support	1	13	1b	1			
Unused 31:16 FFFFH FFFFH	Unused		1	15:14	11b	1			
	Unused		1	31:16	FFFFH	FFFFH			

8. ELECTRICAL CHARACTERISTICS

8.1. POWER-ON TIMING

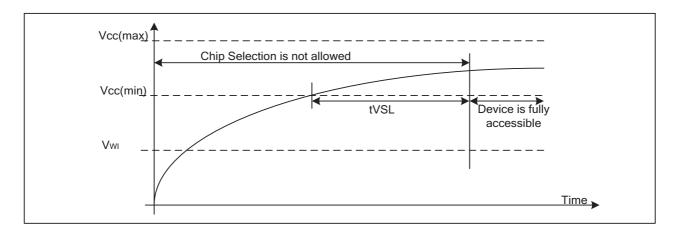


Table6. Power-Up Timing and Write Inhibit Threshold

Symbol	Parameter	Min.	Max.	Unit
tVSL	VCC (min.) to device operation	2.5		ms
VWI	Write Inhibit Voltage	1	1.5	V

8.2. INITIAL DELIVERY STATE

The device is delivered with the memory array erased: all bits are set to 1(each byte contains FFH). The Status Register bits are set to 0, except QE bit (S9) is set to 1.

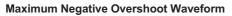
8.3. ABSOLUTE MAXIMUM RATINGS

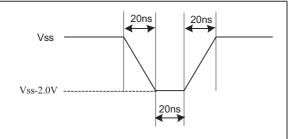
Parameter	Value	Unit
Ambient Operating Temperature	-40 to 85	°C
Storage Temperature	-65 to 150	°C
Transient Input/Output Voltage (note: overshoot)	-2.0 to VCC+2.0	V
Applied Input/Output Voltage	-0.6 to VCC+0.4	V
VCC	-0.6 to 2.5	V

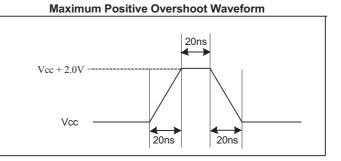




Figure41. Input Test Waveform and Measurement Level



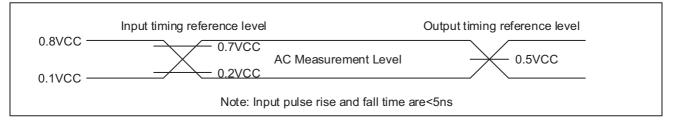




8.4. CAPACITANCE MEASUREMENT CONDITIONS

Symbol	Parameter	Min	Тур.	Мах	Unit	Conditions
CIN	Input Capacitance			6	pF	VIN=0V
COUT	Output Capacitance			8	pF	VOUT=0V
CL	Load Capacitance	30		рF		
	Input Rise And Fall time			5	ns	
	Input Pause Voltage	0.1VCC to 0.8VCC		C	V	
	Input Timing Reference Voltage	0.2VCC to 0.7VCC		V		
	Output Timing Reference Voltage	0.5VCC		V		

Figure42. Input Test Waveform and Measurement Level







8.5. DC CHARACTERISTICS

(T= -40°C~85°C, VCC=1.65~2.0V)

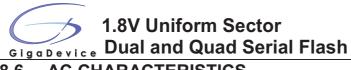
Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit.
ILI	Input Leakage Current				±4	μA
ILO	Output Leakage Current				±4	μA
Icc1	Standby Current	CS#=VCC,		70	100	μA
		V _{IN} =VCC or VSS				
Icc2	Deep Power-Down Current	CS#=VCC,		2	16	μA
		V _{IN} =VCC or VSS				
		CLK=0.1VCC /				
		0.9VCC		15	20	
		at 120MHz,		15	20	mA
	Operating Courset (Deed)	Q=Open(*1,*2,*4 I/O)				
Icc3	Operating Current (Read)	CLK=0.1VCC /				
		0.9VCC		13	10	
		at 80MHz,		13	18	mA
		Q=Open(*1,*2,*4 I/O)				
Icc4	Operating Current (PP)	CS#=VCC			20	mA
I _{CC5}	Operating Current (WRSR)	CS#=VCC			20	mA
Icc6	Operating Current (SE)	CS#=VCC			20	mA
I _{CC7}	Operating Current (BE)	CS#=VCC			20	mA
Icc8	Operating Current (CE)	CS#=VCC			20	mA
VIL	Input Low Voltage		-0.5		0.2VCC	V
VIH	Input High Voltage		0.7VCC		VCC+0.4	V
Vol	Output Low Voltage	l _{o∟} =100μA			0.2	V
Vон	Output High Voltage	І _{ОН} =-100µА	VCC-0.2			V

Note:

1. Typical values given for TA=25°C.

2. Value guaranteed by design and/or characterization, not 100% tested in production.





8.6. AC CHARACTERISTICS

(T= -40°C~85°C, VCC=1.65~2.0V, CL=30pf)

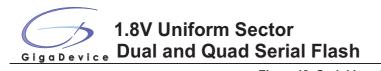
Symbol	Parameter	Min.	Тур.	Max.	Unit.
fc	Serial Clock Frequency For: all command except for 03H			120	MHz
f _R	Serial Clock Frequency For: Read (03H)			80	MHz
tclh	Serial Clock High Time	3.5			ns
t _{CLL}	Serial Clock Low Time	3.5			ns
t _{CLCH}	Serial Clock Rise Time (Slew Rate)	0.1			V/ns
t _{CHCL}	Serial Clock Fall Time (Slew Rate)	0.1			V/ns
t slch	CS# Active Setup Time	5			ns
tснян	CS# Active Hold Time	5			ns
tsнсн	CS# Not Active Setup Time	5			ns
t _{CHSL}	CS# Not Active Hold Time	5			ns
tshsl	CS# High Time (Read/Write)	20			ns
tsнqz	Output Disable Time			6	ns
tclax	Output Hold Time	1.2			ns
t _{DVCH}	Data In Setup Time	2			ns
t _{CHDX}	Data In Hold Time	2			ns
tclqv	Clock Low To Output Valid			7	ns
t _{RST}	CS# High To Next Command After Reset (Except From Erase)			30	μs
t _{RST_E}	CS# High To Next Command After Reset (From Erase)			12	ms
t _{DP}	CS# High To Deep Power-Down Mode			20	μs
t _{RES1}	CS# High To Standby Mode Without Electronic Signature Read			20	μs
t _{RES2}	CS# High To Standby Mode With Electronic Signature Read			20	μs
tsus	CS# High To Next Command After Suspend			20	μs
t _{RS}	Latency Between Resume And Next Suspend	100			μs
tw	Write Status Register Cycle Time		10	60	ms
t _{PP}	Page Programming Time		0.5	2.4	ms
tse	Sector Erase Time		70	400	ms
t _{BE1}	Block Erase Time (32K Bytes)		0.16	0.8	s
t _{BE2}	Block Erase Time (64K Bytes)		0.3	1.2	s
t _{CE}	Chip Erase Time (GD25LB256D)		100	240	s

Note:

1. Typical values given for TA=25°C.

2. Value guaranteed by design and/or characterization, not 100% tested in production.





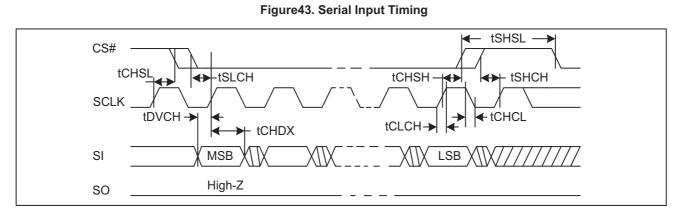
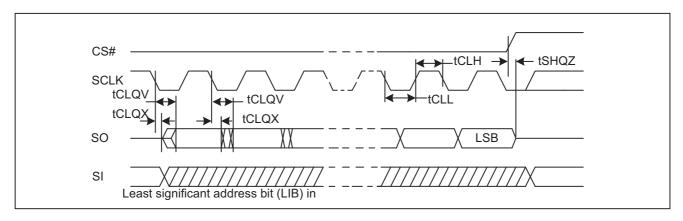
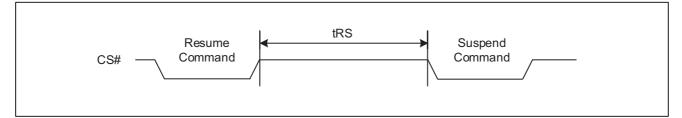


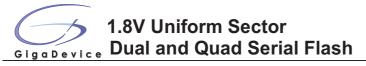
Figure44. Output Timing



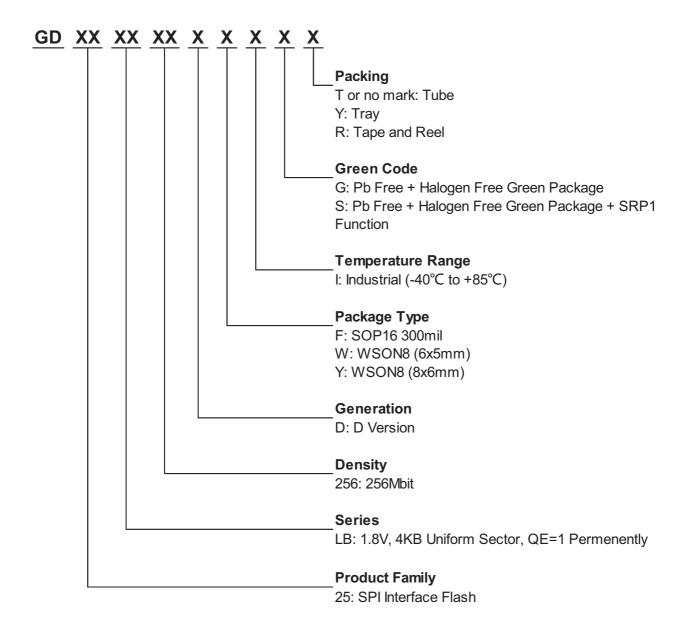




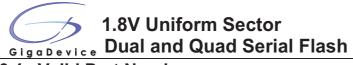




9. ORDERING INFORMATION





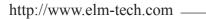


9.1. Valid Part Numbers

Please contact GigaDevice regional sales for the latest product selection and available form factors.

Temperature Range I: Industrial (-40°C to +85°C)

Product Number	Density	Package Type
GD25LB256DFIG	256Mbit	SOP16 300mil
GD25LB256DFIS	2301/1011	SOF 10 300111
GD25LB256DWIG	256Mbit	MCONR (GyEmm)
GD25LB256DWIS	230101011	WSON8 (6x5mm)
GD25LB256DYIG	256Mbit	MCONR (Promm)
GD25LB256DYIS	256Mbit	WSON8 (8x6mm)



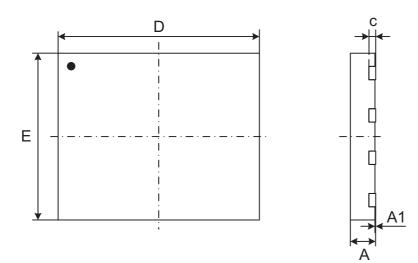




GD25LB256D

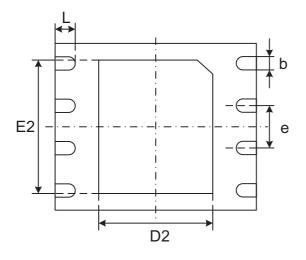
10. PACKAGE INFORMATION

10.1. Package WSON8 (6*5mm)





Side View



Bottom View

Dimensions

Symbol		٨	1		h	D	D 2	Е	E2		
U	Jnit	Α	A1	С	b	D	D2	E	EZ	e	L
	Min	0.70	0.00	0.180	0.35	5.90	3.30	4.90	3.90		0.50
mm	Nom	0.75	0.02	0.203	0.40	6.00	3.40	5.00	4.00	1.27	0.60
	Max	0.80	0.05	0.250	0.50	6.10	3.50	5.10	4.10		0.75

Note:

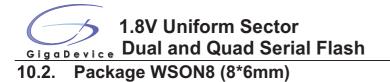
1. Both the package length and width do not include the mold flash.

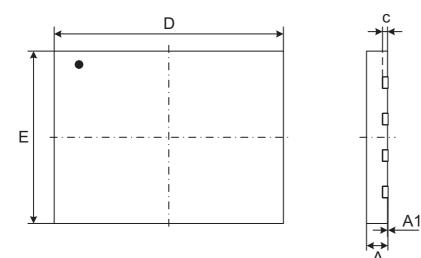
2. The exposed metal pad area on the bottom of the package is floating.

3. Coplanarity ≤ 0.08 mm. Package edge tolerance ≤ 0.10 mm.

4. The lead shape may be of little difference according to different package lead frames. These lead shapes are compatible with each other.

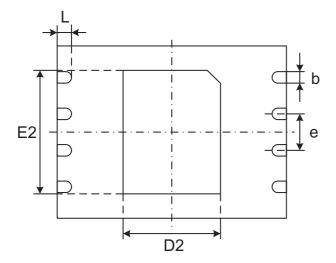














Dimensions

Syı	mbol	٨	A1		h	D	D2	Е	E2		
U	Jnit	A	AI	С	b	D	DZ	E		е	L
	Min	0.70	0.00	0.180	0.35	7.90	3.30	5.90	4.20		0.45
mm	Nom	0.75	0.02	0.203	0.40	8.00	3.40	6.00	4.30	1.27	0.50
	Мах	0.80	0.05	0.250	0.45	8.10	3.50	6.10	4.40		0.55

Note:

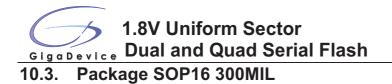
1. Both the package length and width do not include the mold flash.

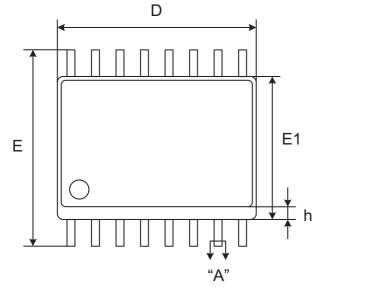
2. The exposed metal pad area on the bottom of the package is floating.

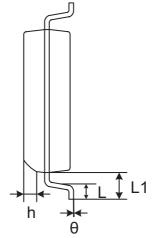
3. Coplanarity ≤ 0.08 mm. Package edge tolerance ≤ 0.10 mm.

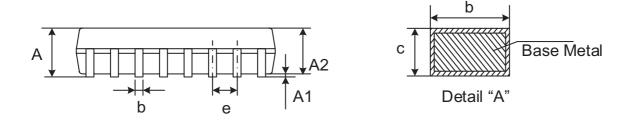
4. The lead shape may be of little difference according to different package lead frames. These lead shapes are compatible with each other.











Dimensions

Sy	mbol	- A	A1	A2	b	с	D	Е	E1	е	1	L1	h	θ
U	Init			~~						C	-	L.		5
	Min	-	0.10	2.05	0.31	0.10	10.20	10.10	7.40		0.40		0.25	0
mm	Nom	-	0.20	-	0.41	0.25	10.30	10.30	7.50	1.27	-	1.40	-	-
	Max	2.65	0.30	2.55	0.51	0.33	10.40	10.50	7.60		1.27		0.75	8

Note:

1. Both the package length and width do not include the mold flash.

2. Seating plane: Max. 0.1mm.







11. REVISION HISTORY

Version No	Description	Page	Date
1.0	Initial Release	All	2017-12-26
1.1	Modify ILI max value from ±2uA to ±4uA	P68	2017-1-12
1.1	Modify ILO max value from ±2uA to ±4uA	P68	2017-1-12
1.2	Modify the description of 03H command	P25	2018-3-16
	Add 4BH command	P53	
	Modify the sequence diagram of 42H command	P55	
	Modify tVSL min. value from 5ms to 2.5ms	P68	
	Add tRS, of which the min value is 100us	P71	
1.3	Modify tPP typ. value from 0.7ms to 0.5ms	P71	2018-8-8
	Modify tSE from 90-500ms to 70ms-400ms	P71	
	Modify tBE1 typ. value from 0.3s to 0.16s	P71	
	Modify tBE2 from 0.5-1.5s to 0.3-1.2s	P71	
	Modify tCE from 200-400s to 100-240s	P71	
1.4	Modify SFDP @32H from F1H to F3H	P65	2018-10-18





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